

## Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

### FEATURES

- Qualified for Automotive Applications
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Output Swing Includes Both Supply Rails
- Extended Common-Mode Input Voltage Range: 0 V to 4.25 V (Min) at 5-V Single Supply
- No Phase Inversion
- Low Noise: 16 nV/ $\sqrt{\text{Hz}}$  Typ at  $f = 1 \text{ kHz}$
- Low Input Offset Voltage: 950  $\mu\text{V}$  Max at  $T_A = 25^\circ\text{C}$  (TLV244xA)
- Low Input Bias Current: 1 pA (Typ)
- 600- $\Omega$  Output Drive
- High-Gain Bandwidth: 1.8 MHz (Typ)
- Low Supply Current: 750  $\mu\text{A}$  Per Channel (Typ)
- Macromodel Included

### DESCRIPTION

The TLV244x and TLV244xA are low-voltage operational amplifiers from Texas Instruments. The common-mode input voltage range of these devices has been extended over typical standard CMOS amplifiers, making them suitable for a wide range of applications. In addition, these devices do not phase invert when the common-mode input is driven to the supply rails. This satisfies most design requirements without paying a premium for rail-to-rail input performance. They also exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. This family is fully characterized at 3-V and 5-V supplies and is optimized for low-voltage operation. Both devices offer comparable ac performance while having lower noise, input offset voltage, and power dissipation than existing CMOS operational amplifiers. The TLV244x has increased output drive over previous rail-to-rail operational amplifiers and can drive 600- $\Omega$  loads for telecommunications applications.

The other members in the TLV244x family are the low-power, TLV243x, and micro-power, TLV2422, versions.

The TLV244x, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels and low-voltage operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLV244xA is available with a maximum input offset voltage of 950  $\mu\text{V}$ .

If the design requires single operational amplifiers, see the TI TLV2211/21/31. This is a family of rail-to-rail output operational amplifiers in the SOT-23 package. Their small size and low power consumption make them ideal for high-density battery-powered equipment.

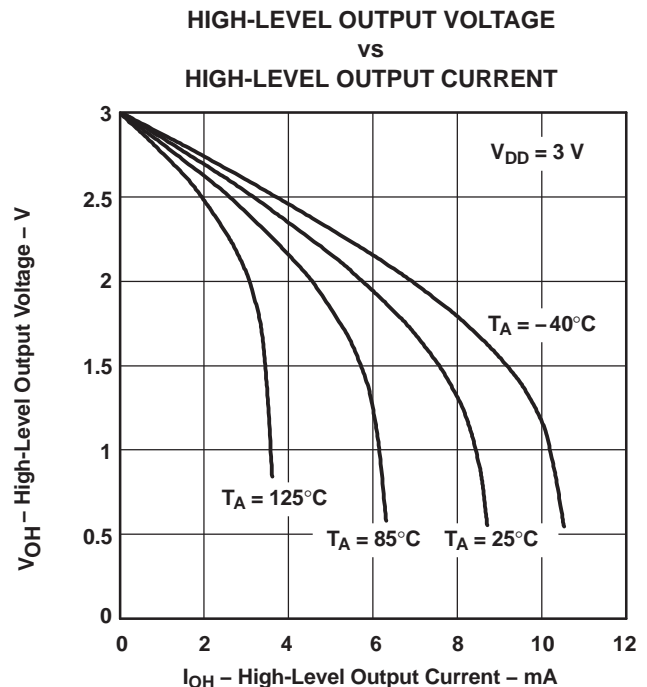


Figure 1.



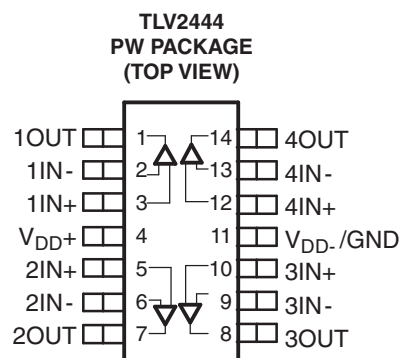
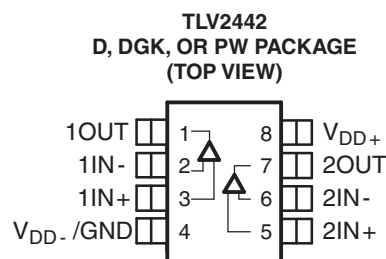
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**ORDERING INFORMATION<sup>(1)</sup>**

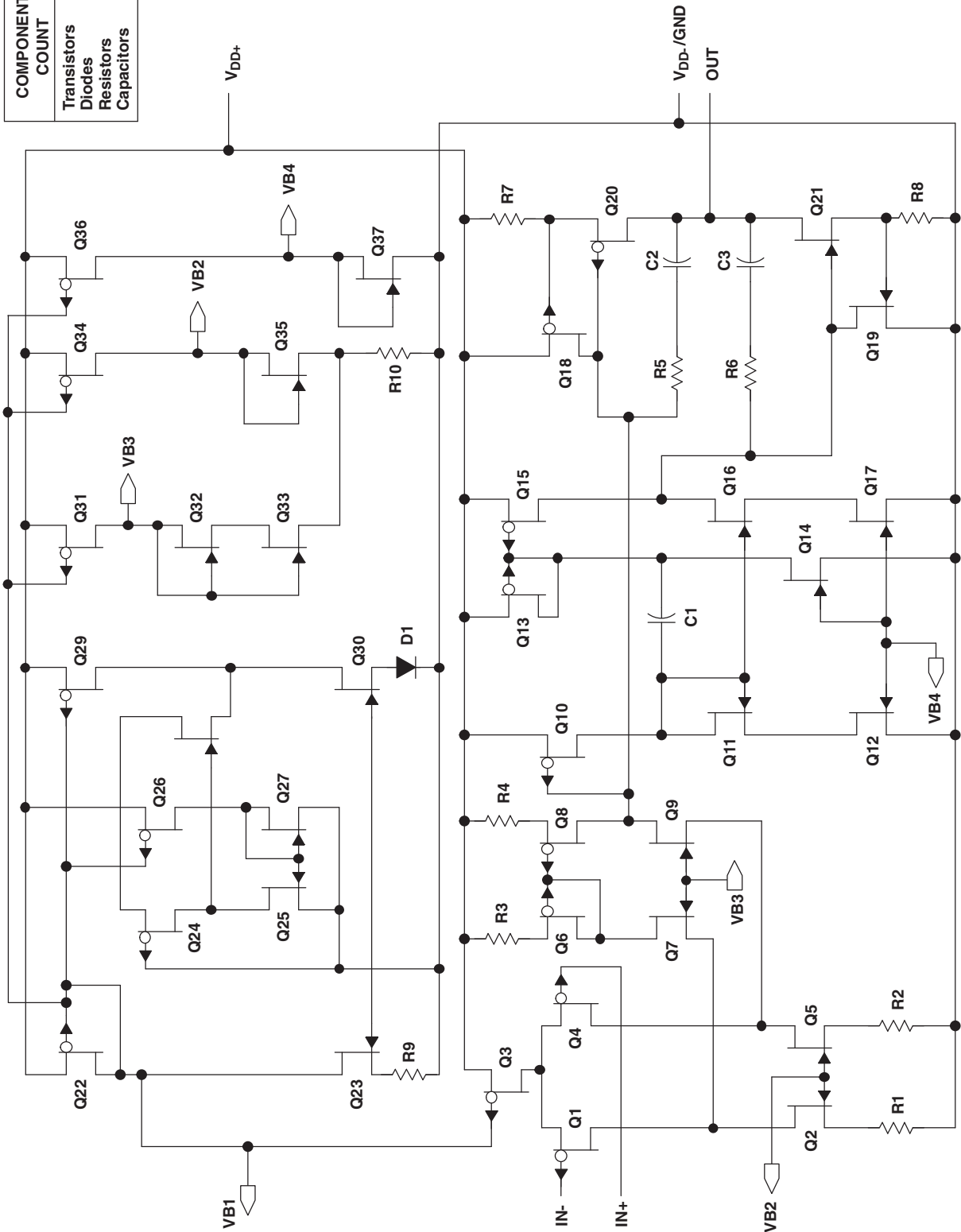
| T <sub>A</sub> | V <sub>IO</sub> max<br>AT 25 = C | PACKAGE <sup>(2)</sup> |            |              | ORDERABLE PART<br>NUMBER | TOP-SIDE MARKING |
|----------------|----------------------------------|------------------------|------------|--------------|--------------------------|------------------|
|                |                                  |                        |            |              |                          |                  |
| -40°C to 125°C | 950 μV                           | Dual                   | SOIC – D   | Reel of 2500 | TLV2442AQDRQ1            | 2442AQ           |
|                |                                  |                        | TSSOP – PW | Reel of 2000 | TLV2442AQPWRQ1           | 2442AQ           |
|                | 2.5 mV                           | Dual                   | MSOP – DGK | Reel of 2500 | TLV2442QDQKRQ1           | OBR              |
|                |                                  |                        | SOIC – D   | Reel of 2500 | TLV2442QDRQ1             | 2442Q1           |
|                |                                  |                        | TSSOP – PW | Reel of 2000 | TLV2442QPWRQ1            | 2442Q1           |
|                | 950 μV                           | Quad                   | TSSOP – PW | Reel of 2000 | TLV2444AQPWRQ1           | 2444AQ           |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).



EQUIVALENT SCHEMATIC (EACH AMPLIFIER)

| COMPONENT COUNT |    |
|-----------------|----|
| Transistors     | 69 |
| Diodes          | 5  |
| Resistors       | 26 |
| Capacitors      | 6  |



## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |   |                              |
|------------------|---|------------------------------|
| V <sub>DD</sub>  | Supply voltage <sup>(2)</sup>   | 12 V                         |
| V <sub>ID</sub>  | Differential input voltage <sup>(3)</sup>                             | ±V <sub>DD</sub>             |
| V <sub>I</sub>   | Input voltage (any input) <sup>(2)</sup>                              | −0.3 V to V <sub>DD</sub>    |
| I <sub>I</sub>   | Input current (any input)   | ±5 mA                        |
| I <sub>O</sub>   | Output current  | ±50 mA                       |
|                  | Total current into V <sub>DD+</sub>                                   | ±50 mA                       |
|                  | Total current out of V <sub>DD−</sub>                                 | ±50 mA                       |
|                  | Duration of short-circuit current at (or below) 25 = C <sup>(4)</sup> | Unlimited                    |
|                  | Continuous total dissipation  | See Dissipation Rating Table |
| T <sub>A</sub>   | Operating free-air temperature range                                  | −40°C to 125°C               |
| T <sub>stg</sub> | Storage temperature range   | −65°C to 150°C               |
|                  | Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds          | 260°C                        |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential voltages, are with respect to the midpoint between V<sub>DD+</sub> and V<sub>DD−</sub>.
- (3) Differential voltages are at IN+ with respect to IN−. Excessive current will flow if input is brought below V<sub>DD−</sub> − 0.3 V.
- (4) The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

## DISSIPATION RATINGS

| PACKAGE     | T <sub>A</sub> ≤ 25°C<br>POWER RATING | DERATING FACTOR<br>ABOVE T <sub>A</sub> = 25°C | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 85°C<br>POWER RATING | T <sub>A</sub> = 125°C<br>POWER RATING |
|-------------|---------------------------------------|--|---------------------------------------|---------------------------------------|--|
| D (8 pin)   | 725 mW                                | 5.8 mW/°C                                      | 464 mW                                | 377 mW                                | 145 mW                                 |
| DGK (8 pin) | 606 mW                                | 4.847 mW/°C                                    | 388 mW                                | 315 mW                                | 121 mW                                 |
| PW (8 pin)  | 525 mW                                | 4.2 mW/°C                                      | 336 mW                                | 273 mW                                | 105 mW                                 |
| PW (14 pin) | 720 mW                                | 5.6 mW/°C                                      | 634 mW                                | 547 mW                                | 317 mW                                 |

## RECOMMENDED OPERATING CONDITIONS

|                 |                                | MIN              | MAX                  | UNIT |
|-----------------|--------------------------------|------------------|----------------------|------|
| V <sub>DD</sub> | Supply voltage                 | 2.7              | 10                   | V    |
| V <sub>I</sub>  | Input voltage                  | V <sub>DD−</sub> | V <sub>DD+</sub> − 1 | V    |
| V <sub>IC</sub> | Common-mode input voltage      | V <sub>DD−</sub> | V <sub>DD+</sub> − 1 | V    |
| T <sub>A</sub>  | Operating free-air temperature | −40              | 125                  | °C   |

## ELECTRICAL CHARACTERISTICS

$V_{DD} = 3\text{ V}$ , at specified free-air temperature (unless otherwise noted)

| PARAMETER   | TEST CONDITIONS  | $T_A$ <sup>(1)</sup>     | MIN        | TYP          | MAX  | UNIT                         |
|---|--|--------------------------|------------|--------------|------|------------------------------|
| $V_{IO}$ Input offset voltage   | $V_{IC} = 1.5\text{ V}$ , $V_O = 1.5\text{ V}$ ,<br>$R_S = 50\ \Omega$ | TLV244x                  | 25°C       | 300          | 2000 | $\mu\text{V}$                |
|   |  |                          | Full range |              | 2500 |                              |
|   |  | TLV244xA                 | 25°C       | 300          | 950  |                              |
|   |  |                          | Full range |              | 1600 |                              |
| $\alpha_{VIO}$ Temperature coefficient of input offset voltage                | $V_{IC} = 1.5\text{ V}$ , $V_O = 1.5\text{ V}$ , $R_S = 50\ \Omega$    | 25°C to 85°C             |            | 2            |      | $\mu\text{V}/^\circ\text{C}$ |
| Input offset voltage long-term drift <sup>(2)</sup>                           | $V_{IC} = 1.5\text{ V}$ , $V_O = 1.5\text{ V}$ , $R_S = 50\ \Omega$    | 25°C                     |            | 0.002        |      | $\mu\text{V}/\text{mo}$      |
| $I_{IO}$ Input offset current   | $V_{IC} = 1.5\text{ V}$ , $V_O = 1.5\text{ V}$ , $R_S = 50\ \Omega$    | 25°C                     |            | 0.5          |      | $\text{pA}$                  |
|   |  | Full range               |            |              | 150  |                              |
| $I_{IB}$ Input bias current   | $V_{IC} = 1.5\text{ V}$ , $V_O = 1.5\text{ V}$ , $R_S = 50\ \Omega$    | 25°C                     |            | 1            |      | $\text{pA}$                  |
|   |  | Full range               |            |              | 260  |                              |
| $V_{ICR}$ Common-mode input voltage range                                     | $ V_{IO}  \leq 8\text{ mV}$ , $R_S = 50\ \Omega$                       | 25°C                     | 0 to 2.25  | -0.25 to 2.5 |      | $\text{V}$                   |
|   |  | Full range               | 0.2 to 2   |              |      |                              |
| $V_{OH}$ High-level output voltage  | $I_O = -100\ \mu\text{A}$  | 25°C                     |            | 2.98         |      | $\text{V}$                   |
|   | $I_O = -3\text{ mA}$   | 25°C                     |            | 2.5          |      |                              |
|   | Full range   |                          | 2.25       |              |      |                              |
| $V_{OL}$ Low-level output voltage   | $V_{IC} = 1.5\text{ V}$  | $I_O = 100\ \mu\text{A}$ | 25°C       | 0.02         |      | $\text{V}$                   |
|   |  | $I_O = 3\text{ mA}$      | 25°C       | 0.63         |      |                              |
|   |  | Full range               |            |              | 1    |                              |
| $A_{VD}$ Large-signal differential voltage amplification                      | $V_O = 1\text{ V to }2\text{ V}$                                       | $R_L = 600\ \Omega$      | 25°C       | 0.7          | 1    | $\text{V/mV}$                |
|   |  |                          | Full range | 0.4          |      |                              |
|   |  | $R_L = 1\text{ M}\Omega$ | 25°C       |              | 750  |                              |
| $r_{id}$ Differential input resistance  |  | 25°C                     |            | 1000         |      | $\text{G}\Omega$             |
| $r_i$ Common-mode input resistance  |  | 25°C                     |            | 1000         |      | $\text{G}\Omega$             |
| $c_i$ Common-mode input capacitance   | $f = 10\text{ kHz}$  | 25°C                     |            | 8            |      | $\text{pF}$                  |
| $z_o$ Closed-loop output impedance  | $f = 1\text{ MHz}$ , $A_V = 10$  | 25°C                     |            | 130          |      | $\Omega$                     |
| CMRR Common-mode rejection ratio  | $V_{IC} = V_{ICR\text{ MIN}}$ , $V_O = V_{DD}/2$ , $R_S = 50\ \Omega$  | 25°C                     | 65         | 75           |      | $\text{dB}$                  |
|   |  | Full range               | 50         |              |      |                              |
| $k_{SVR}$ Supply-voltage rejection ratio ( $\Delta V_{DD\pm}/\Delta V_{IO}$ ) | $V_{DD} = 2.7\text{ V to }8\text{ V}$ , $V_{IC} = V_{DD}/2$ , No load  | 25°C                     | 80         | 95           |      | $\text{dB}$                  |
|   |  | Full range               | 80         |              |      |                              |
| $I_{DD}$ Supply current (per channel)   | $V_O = 1.5\text{ V}$ , No load   | 25°C                     |            | 725          | 1100 | $\mu\text{A}$                |
|   |  | Full range               |            |              | 1100 |                              |

(1) Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

(2) Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.

## OPERATING CHARACTERISTICS

$V_{DD} = 3\text{ V}$ , at specified free-air temperature (unless otherwise noted)

| PARAMETER   |   | TEST CONDITIONS   |  | $T_A^{(1)}$ | MIN         | TYP | MAX                    | UNIT                   |
|-------------|---|---|--|-------------|-------------|-----|------------------------|------------------------|
| SR          | Slew rate at unity gain                     | $V_O = 1\text{ V to }2\text{ V}$ , $R_L = 600\ \Omega$ ,<br>$C_L = 100\text{ pF}$                       |  | 25°C        | 0.65        | 1.3 |                        | V/ $\mu\text{s}$       |
|             |   |   |  | Full range  | 0.4         |     |                        |                        |
| $V_n$       | Equivalent input noise voltage              |   |  | 25°C        | 170         |     |                        | nV/ $\sqrt{\text{Hz}}$ |
|             |   |   |  |             | 18          |     |                        |                        |
| $V_{n(PP)}$ | Peak-to-peak equivalent input noise voltage | $f = 0.1\text{ Hz to }1\text{ Hz}$<br>$f = 0.1\text{ Hz to }10\text{ Hz}$                               |  | 25°C        | 2.6         |     |                        | $\mu\text{V}$          |
|             |   |   |  |             | 5.1         |     |                        |                        |
| $I_n$       | Equivalent input noise current              |   |  | 25°C        | 0.6         |     | fA/ $\sqrt{\text{Hz}}$ |                        |
| THD+N       | Total harmonic distortion plus noise        | $V_O = 0.5\text{ V to }2.5\text{ V}$ ,<br>$R_L = 600\ \Omega$ , $f = 1\text{ kHz}$                      |  | 25°C        | $A_V = 1$   |     | 0.08                   | %                      |
|             |   |   |  |             | $A_V = 10$  |     |                        |                        |
|             |   |   |  |             | $A_V = 100$ |     |                        |                        |
|             | Gain-bandwidth product                      | $f = 10\text{ kHz}$ , $R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$                                       |  | 25°C        | 1.75        |     | MHz                    |                        |
| BOM         | Maximum output-swing bandwidth              | $V_{O(PP)} = 1\text{ V}$ , $R_L = 600\ \Omega$ , $A_V = 1$ ,<br>$C_L = 100\text{ pF}$                   |  | 25°C        | 0.9         |     | MHz                    |                        |
| $t_s$       | Settling time                               | $A_V = -1$ ,<br>Step = $-2.3\text{ V to }2.3\text{ V}$ ,<br>$R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$ |  | 25°C        | To 0.1%     |     | 1.5                    | $\mu\text{s}$          |
|             |   |   |  |             | To 0.01%    |     |                        |                        |
| $\phi_m$    | Phase margin at unity gain                  | $R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$   |  | 25°C        | 65          |     | $^\circ$               |                        |
|             | Gain margin                                 | $R_L = 600\ \Omega$ , $C_L = 100\text{ pF}$   |  | 25°C        | 9           |     | dB                     |                        |

(1) Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

## ELECTRICAL CHARACTERISTICS

 $V_{DD} = 5\text{ V}$ , at specified free-air temperature (unless otherwise noted)

| PARAMETER  | TEST CONDITIONS   | $T_A$ <sup>(1)</sup>                                  | MIN        | TYP          | MAX  | UNIT                         |
|--|---|---|------------|--------------|------|------------------------------|
| $V_{IO}$ Input offset voltage  | $V_{DD\pm} = \pm 2.5\text{ V}$ , $V_{IC} = 0$ ,<br>$V_O = 0$ , $R_S = 50\ \Omega$ | TLV244x   | 25°C       | 300          | 2000 | $\mu\text{V}$                |
|  |   |   | Full range |              | 2500 |                              |
|  |   | TLV244xA  | 25°C       | 300          | 950  |                              |
|  |   |   | Full range |              | 1600 |                              |
| $\alpha_{VIO}$ Temperature coefficient of input offset voltage             | $V_{DD\pm} = \pm 2.5\text{ V}$ , $V_{IC} = 0$ , $V_O = 0$ , $R_S = 50\ \Omega$    | 25°C to 85°C  |            | 2            |      | $\mu\text{V}/^\circ\text{C}$ |
| Input offset voltage long-term drift <sup>(2)</sup>                        | $V_{DD\pm} = \pm 2.5\text{ V}$ , $V_{IC} = 0$ , $V_O = 0$ , $R_S = 50\ \Omega$    | 25°C  |            | 0.002        |      | $\mu\text{V}/\text{mo}$      |
| $I_{IO}$ Input offset current  | $V_{DD\pm} = \pm 2.5\text{ V}$ , $V_{IC} = 0$ , $V_O = 0$ , $R_S = 50\ \Omega$    | 25°C  |            | 0.5          |      | $\text{pA}$                  |
|  |   | Full range  |            |              | 150  |                              |
| $I_{IB}$ Input bias current  | $V_{DD\pm} = \pm 2.5\text{ V}$ , $V_{IC} = 0$ , $V_O = 0$ , $R_S = 50\ \Omega$    | 25°C  |            | 1            |      | $\text{pA}$                  |
|  |   | Full range  |            |              | 260  |                              |
| $V_{ICR}$ Common-mode input voltage range                                  | $ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$                                  | 25°C  | 0 to 4.25  | -0.25 to 4.5 |      | $\text{V}$                   |
|  |   | Full range  | 0 to 4     |              |      |                              |
| $V_{OH}$ High-level output voltage   | $I_{OH} = -100\ \mu\text{A}$<br>$I_{OH} = -5\text{ mA}$                           | 25°C  |            | 4.97         |      | $\text{V}$                   |
|  |   | 25°C  |            | 4            | 4.35 |                              |
|  |   | Full range  |            | 4            |      |                              |
| $V_{OL}$ Low-level output voltage  | $V_{IC} = 2.5\text{ V}$   | $I_{OL} = 100\ \mu\text{A}$<br>$I_{OL} = 5\text{ mA}$ | 25°C       |              | 0.01 | $\text{V}$                   |
|  |   |   | 25°C       |              | 0.8  |                              |
|  |   | Full range  |            |              | 1.25 |                              |
| $A_{VD}$ Large-signal differential voltage amplification                   | $V_{IC} = 2.5\text{ V}$ ,<br>$V_O = 1\text{ V to }4\text{ V}$                     | $R_L = 600\ \Omega$ <sup>(3)</sup>                    | 25°C       | 0.9          | 1.3  | $\text{V}/\text{mV}$         |
|  |   |   | Full range |              | 0.5  |                              |
|  |   | $R_L = 1\ \text{M}\Omega$ <sup>(3)</sup>              | 25°C       |              | 950  |                              |
| $r_{id}$ Differential input resistance                                     |   | 25°C  |            | 1000         |      | $\text{G}\Omega$             |
| $r_i$ Common-mode input resistance   |   | 25°C  |            | 1000         |      | $\text{G}\Omega$             |
| $c_i$ Common-mode input capacitance  | $f = 10\text{ kHz}$   | 25°C  |            | 8            |      | $\text{pF}$                  |
| $z_o$ Closed-loop output impedance   | $f = 1\text{ MHz}$ , $A_V = 10$   | 25°C  |            | 140          |      | $\Omega$                     |
| CMRR Common-mode rejection ratio   | $V_{IC} = V_{ICR\text{ MIN}}$ , $V_O = V_{DD}/2$ , $R_S = 50\ \Omega$             | 25°C  | 70         | 75           |      | $\text{dB}$                  |
|  |   | Full range  | 70         |              |      |                              |
| $k_{SVR}$ Supply-voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ ) | $V_{DD} = 4.4\text{ V to }8\text{ V}$ , $V_{IC} = V_{DD}/2$ , No load             | 25°C  | 80         | 95           |      | $\text{dB}$                  |
|  |   | Full range  | 80         |              |      |                              |
| $I_{DD}$ Supply current (per channel)                                      | $V_O = 2.5\text{ V}$ , No load  | 25°C  |            | 750          | 1100 | $\mu\text{A}$                |
|  |   | Full range  |            |              | 1100 |                              |

(1) Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

(2) Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.

(3) Referenced to 2.5 V

## OPERATING CHARACTERISTICS

$V_{DD} = 5\text{ V}$ , at specified free-air temperature (unless otherwise noted)

| PARAMETER              |   | TEST CONDITIONS   |  | $T_A^{(1)}$ | MIN         | TYP | MAX                    | UNIT                   |
|------------------------|---|---|--|-------------|-------------|-----|------------------------|------------------------|
| SR                     | Slew rate at unity gain                     | $V_O = 0.5\text{ V to } 2.5\text{ V}$ , $R_L = 600\ \Omega^{(2)}$ ,<br>$C_L = 100\text{ pF}^{(2)}$                      |  | 25°C        | 0.75        | 1.4 |                        | V/ $\mu\text{s}$       |
|                        |   |   |  | Full range  | 0.5         |     |                        |                        |
| $V_n$                  | Equivalent input noise voltage              |   |  | 25°C        | 130         |     |                        | nV/ $\sqrt{\text{Hz}}$ |
|                        |   |   |  |             | 16          |     |                        |                        |
| $V_{n(PP)}$            | Peak-to-peak equivalent input noise voltage | $f = 0.1\text{ Hz to } 1\text{ Hz}$<br>$f = 0.1\text{ Hz to } 10\text{ Hz}$   |  | 25°C        | 1.8         |     |                        | $\mu\text{V}$          |
|                        |   |   |  |             | 3.6         |     |                        |                        |
| $I_n$                  | Equivalent input noise current              |   |  | 25°C        | 0.6         |     | fA/ $\sqrt{\text{Hz}}$ |                        |
| THD+N                  | Total harmonic distortion plus noise        | $V_O = 1.5\text{ V to } 3.5\text{ V}$ ,<br>$f = 1\text{ kHz}$ , $R_L = 600\ \Omega^{(2)}$                               |  | 25°C        | $A_V = 1$   |     | %                      |                        |
|                        |   |   |  |             | $A_V = 10$  |     |                        |                        |
|                        |   |   |  |             | $A_V = 100$ |     |                        |                        |
| Gain-bandwidth product |   | $f = 10\text{ kHz}$ , $R_L = 600\ \Omega^{(2)}$ ,<br>$C_L = 100\text{ pF}^{(2)}$  |  | 25°C        | 1.81        |     | MHz                    |                        |
| BOM                    | Maximum output-swing bandwidth              | $V_{O(PP)} = 2\text{ V}$ , $A_V = 1$ , $R_L = 600\ \Omega^{(2)}$ ,<br>$C_L = 100\text{ pF}^{(2)}$                       |  | 25°C        | 0.5         |     | MHz                    |                        |
| $t_s$                  | Settling time                               | $A_V = -1$ ,<br>Step = $-0.5\text{ V to } 2.5\text{ V}$ ,<br>$R_L = 600\ \Omega^{(2)}$ ,<br>$C_L = 100\text{ pF}^{(2)}$ |  | 25°C        | To 0.1%     |     | $\mu\text{s}$          |                        |
|                        |   |   |  |             | To 0.01%    |     |                        |                        |
| $\phi_m$               | Phase margin at unity gain                  | $R_L = 600\ \Omega^{(2)}$ , $C_L = 100\text{ pF}^{(2)}$   |  | 25°C        | 68          |     | °                      |                        |
|                        | Gain margin                                 | $R_L = 600\ \Omega^{(2)}$ , $C_L = 100\text{ pF}^{(2)}$   |  | 25°C        | 8           |     | dB                     |                        |

(1) Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

(2) Referenced to 2.5 V

## TYPICAL CHARACTERISTICS

**Table of Graphs<sup>(1)</sup>**

|                |  |                               | <b>FIGURE</b> |
|----------------|--|-------------------------------|---------------|
| $V_{IO}$       | Input offset voltage   | Distribution                  | 2, 3          |
|                |  | vs Common-mode input voltage  | 4, 5          |
| $\alpha_{VIO}$ | Input offset voltage temperature coefficient                     | Distribution                  | 6, 7          |
| $I_B/I_{IO}$   | Input bias and input offset currents                             | vs Free-air temperature       | 8             |
| $V_{OH}$       | High-level output voltage  | vs High-level output current  | 9, 10         |
| $V_{OL}$       | Low-level output voltage   | vs Low-level output current   | 11, 12        |
| $V_{O(PP)}$    | Maximum peak-to-peak output voltage                              | vs Frequency                  | 13            |
| $I_{OS}$       | Short-circuit output current                                     | vs Supply voltage             | 14            |
|                |  | vs Free-air temperature       | 15            |
| $V_O$          | Output voltage   | vs Differential input voltage | 16, 17        |
| $A_{VD}$       | Differential voltage amplification                               | vs Load resistance            | 18            |
|                | Large-signal differential voltage amplification and phase margin | vs Frequency                  | 19, 20        |
|                | Large-signal differential voltage amplification                  | vs Free-air temperature       | 21, 22        |
| $Z_o$          | Output impedance   | vs Frequency                  | 23, 24        |
| CMRR           | Common-mode rejection ratio                                      | vs Frequency                  | 25            |
|                |  | vs Free-air temperature       | 26            |
| $k_{SVR}$      | Supply-voltage rejection ratio                                   | vs Frequency                  | 27, 28        |
|                |  | vs Free-air temperature       | 29            |
| $I_{DD}$       | Supply current   | vs Supply voltage             | 30            |
| SR             | Slew rate  | vs Load capacitance           | 31            |
|                |  | vs Free-air temperature       | 32            |
| $V_O$          | Inverting large-signal pulse response                            |                               | 33, 34        |
|                | Voltage-follower large-signal pulse response                     |                               | 35, 36        |
|                | Inverting small-signal pulse response                            |                               | 37, 38        |
|                | Voltage-follower small-signal pulse response                     |                               | 39, 40        |
| $V_n$          | Equivalent input noise voltage                                   | vs Frequency                  | 41, 42        |
|                | Noise voltage  | Over a 10-second period       | 43            |
| THD + N        | Total harmonic distortion plus noise                             | vs Frequency                  | 44, 45        |
|                |  | vs Free-air temperature       | 46            |
|                |  | vs Supply voltage             | 47            |
| $\phi_m$       | Phase margin   | vs Frequency                  | 19, 20        |
|                |  | vs Load capacitance           | 48            |
|                | Gain margin  | vs Load capacitance           | 49            |
|                |  |                               |               |
| $B_1$          | Unity-gain bandwidth   | vs Load capacitance           | 50            |

(1) For all graphs where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V.

**DISTRIBUTION OF TLV2442  
INPUT OFFSET VOLTAGE**

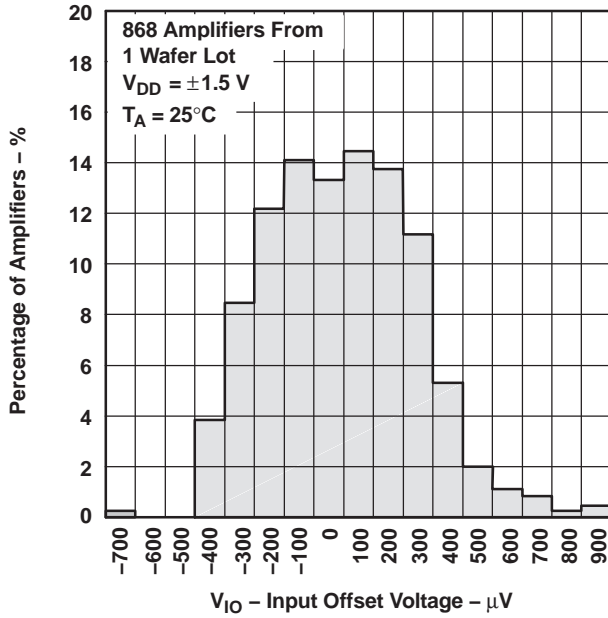


Figure 2.

**DISTRIBUTION OF TLV2442  
INPUT OFFSET VOLTAGE**

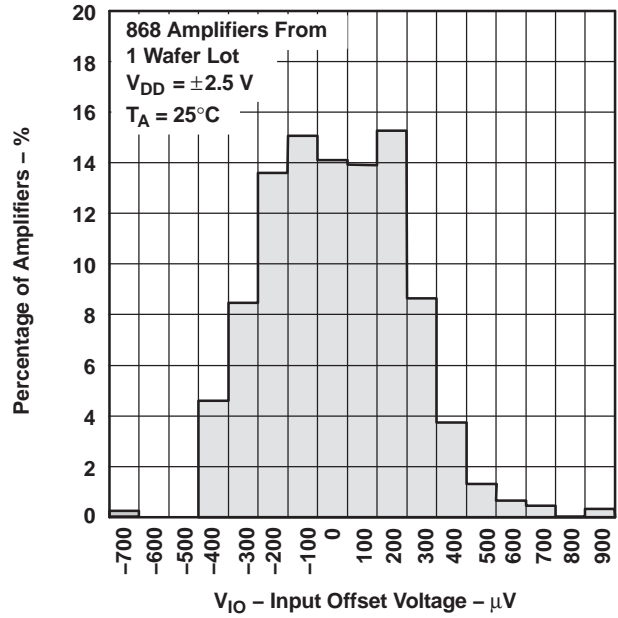


Figure 3.

**INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT VOLTAGE**

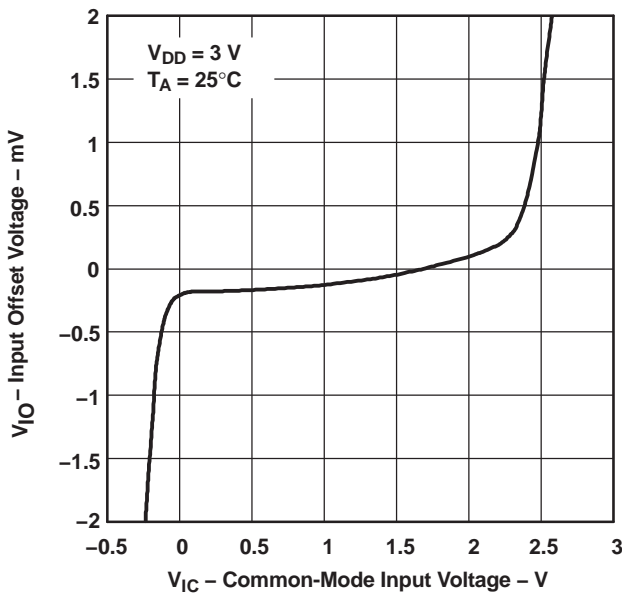


Figure 4.

**INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT VOLTAGE**

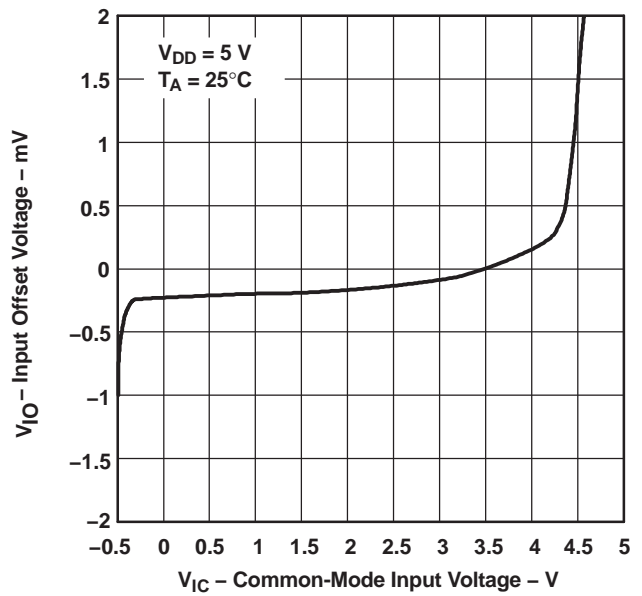


Figure 5.

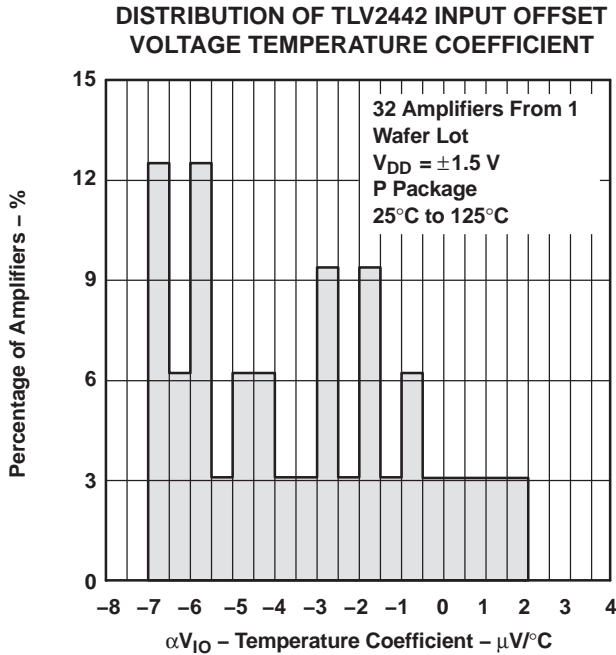


Figure 6.

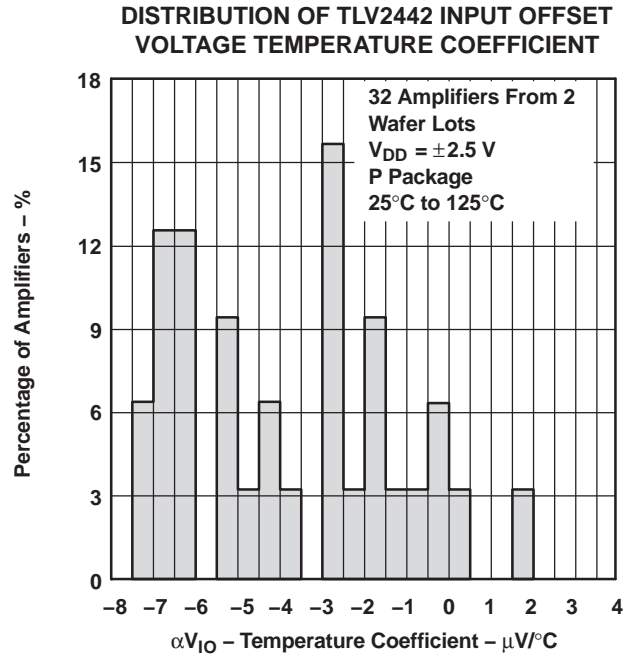


Figure 7.

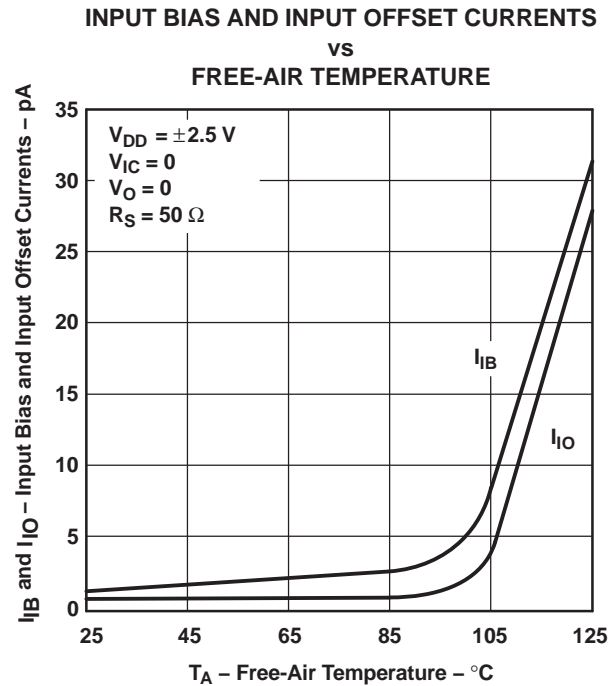


Figure 8.

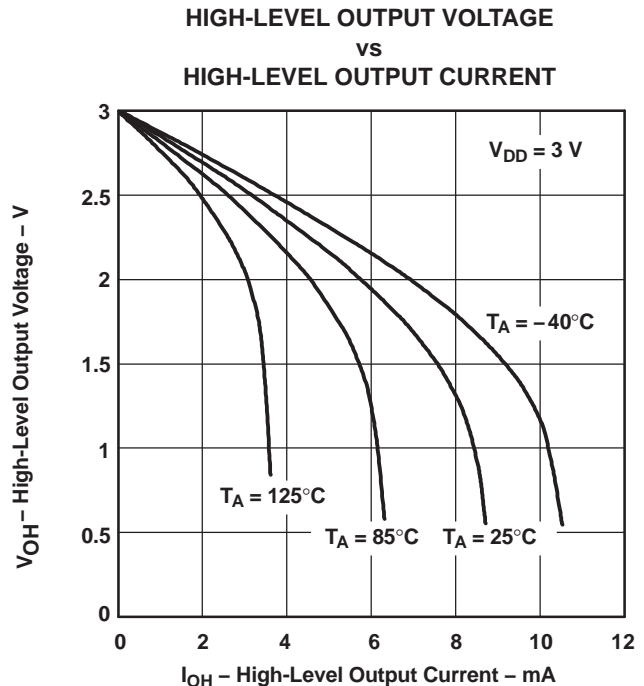
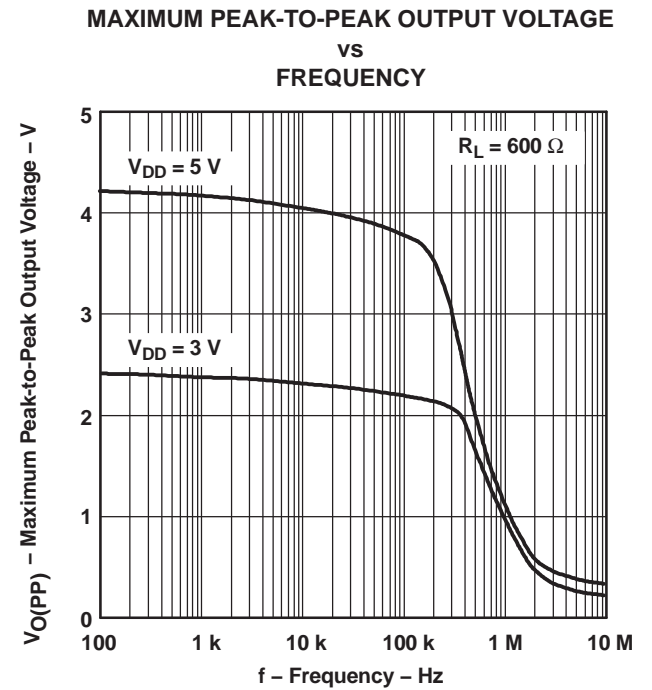
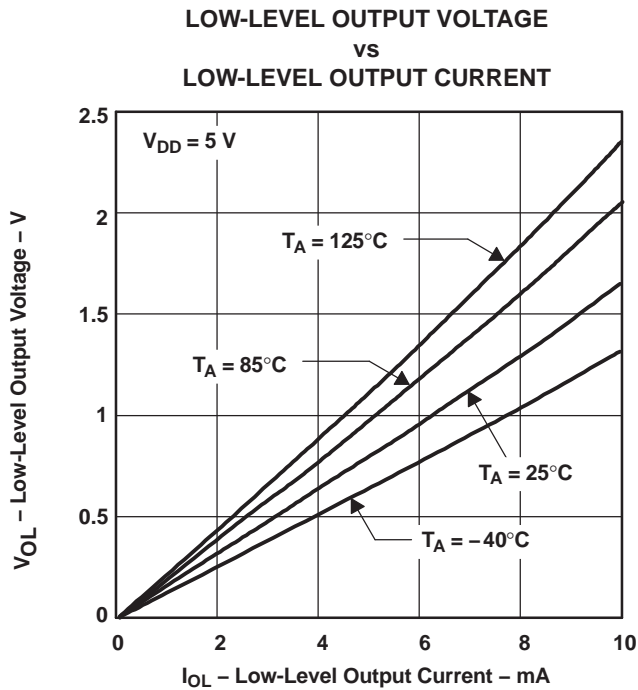
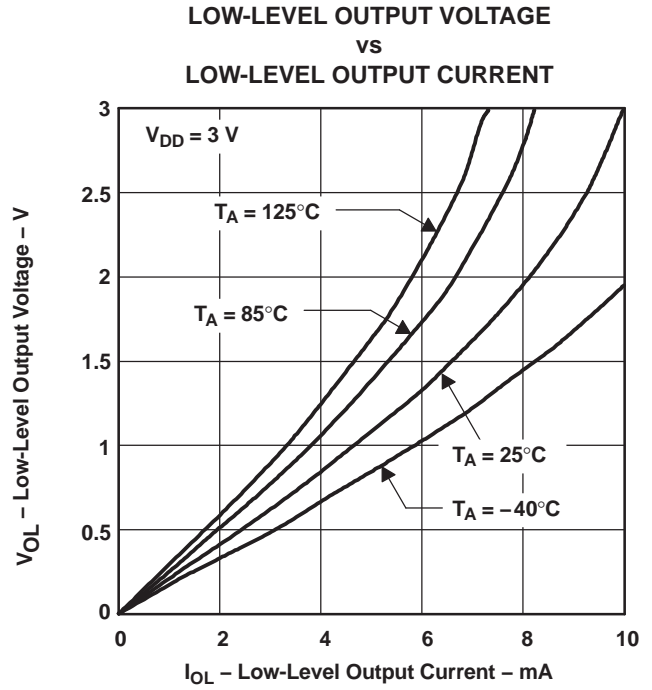
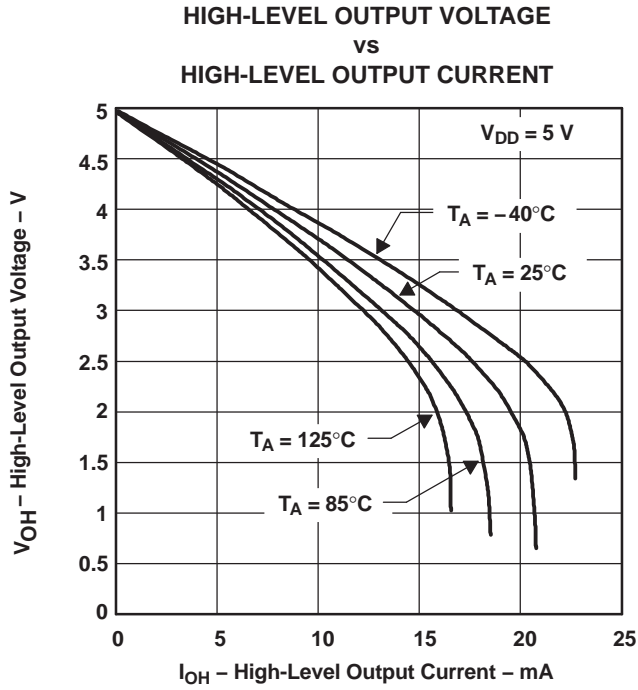


Figure 9.



SHORT-CIRCUIT OUTPUT CURRENT  
VS  
SUPPLY VOLTAGE

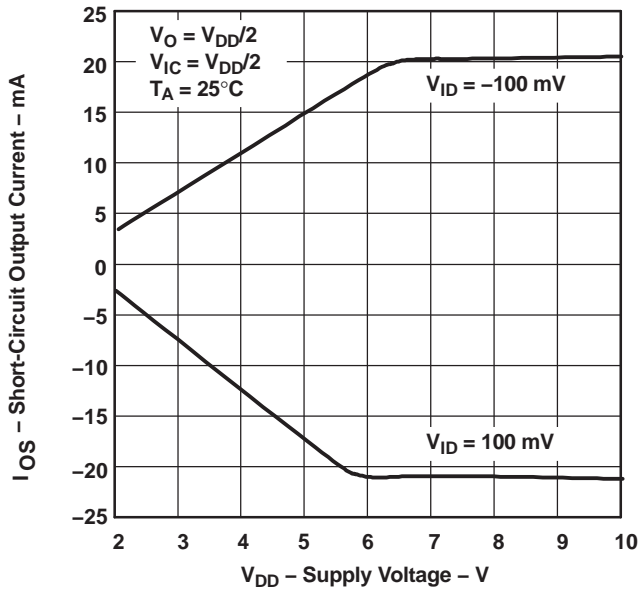


Figure 14.

SHORT-CIRCUIT OUTPUT CURRENT  
VS  
FREE-AIR TEMPERATURE

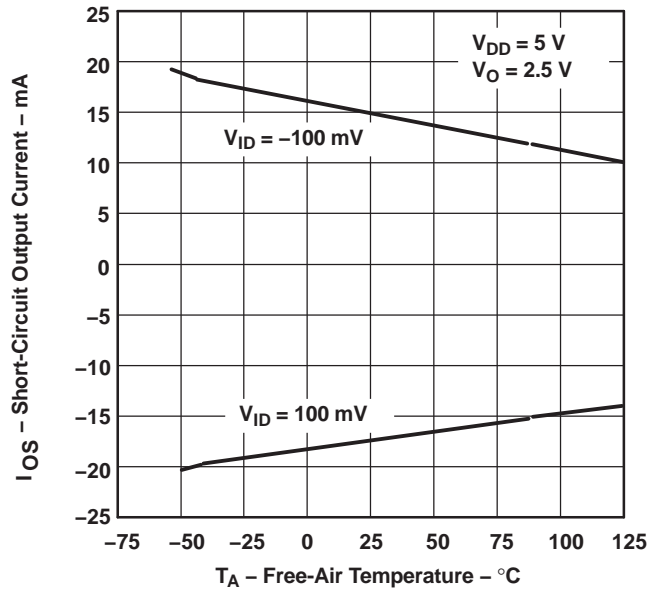


Figure 15.

OUTPUT VOLTAGE  
VS  
DIFFERENTIAL INPUT VOLTAGE

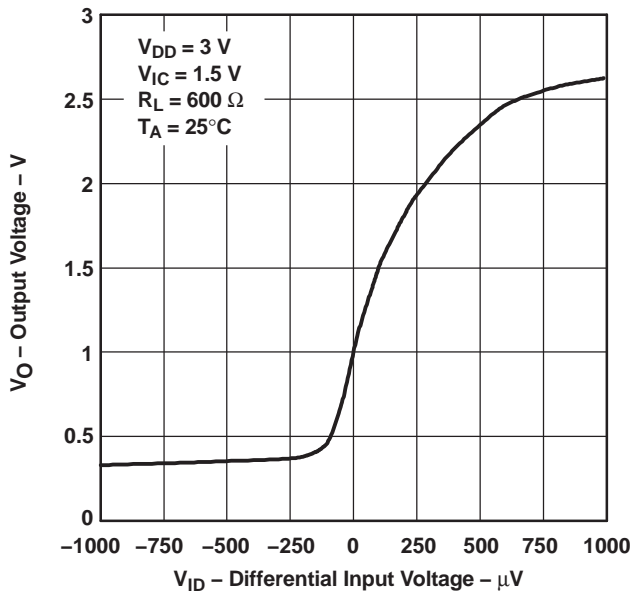


Figure 16.

OUTPUT VOLTAGE  
VS  
DIFFERENTIAL INPUT VOLTAGE

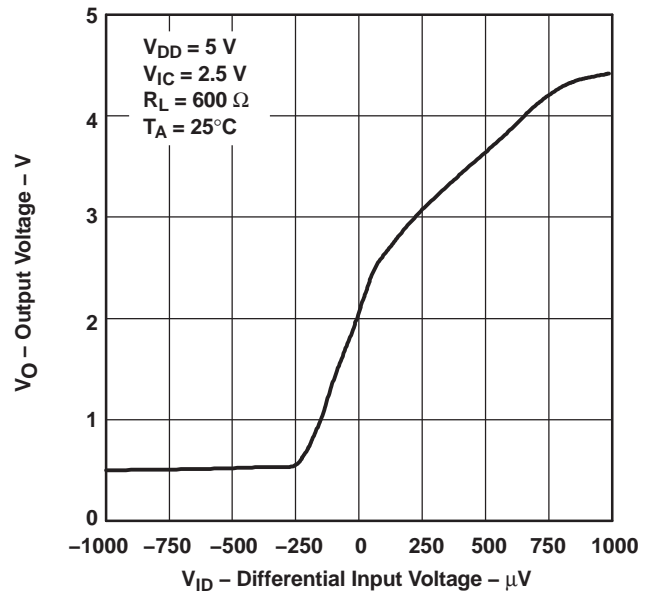
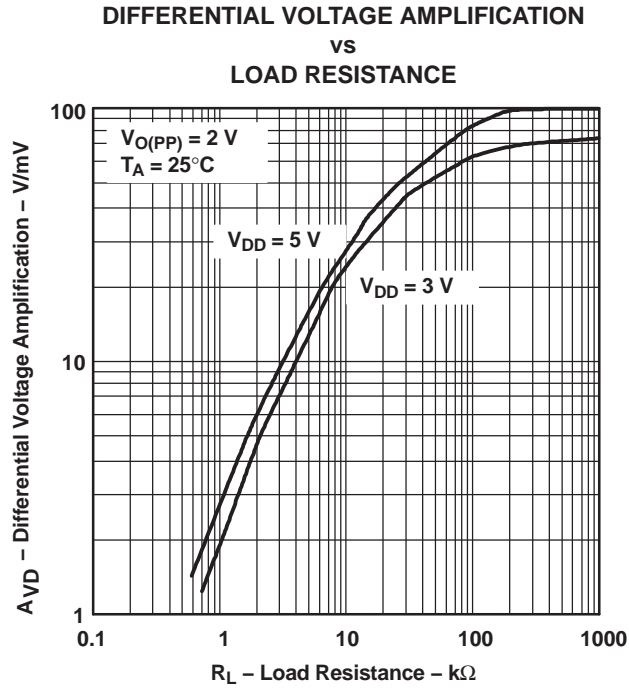
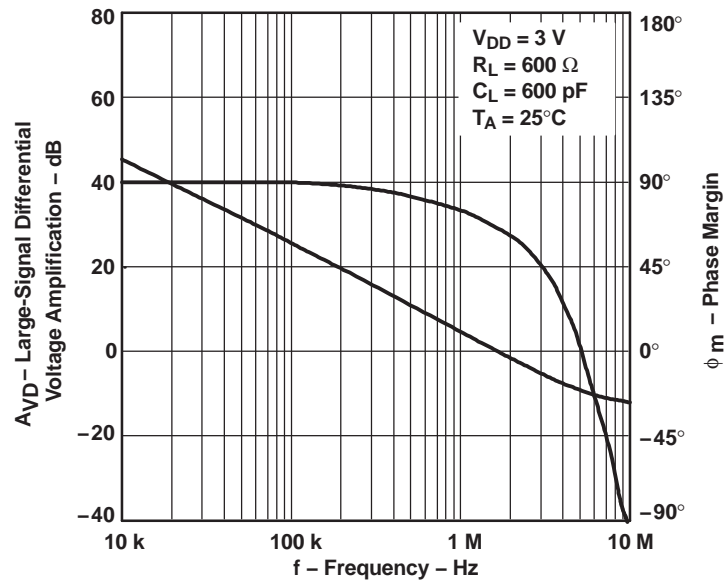


Figure 17.



**Figure 18.  
 LARGE-SIGNAL DIFFERENTIAL VOLTAGE  
 AMPLIFICATION AND PHASE MARGIN  
 vs  
 FREQUENCY**



**Figure 19.**

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN  
vs  
FREQUENCY

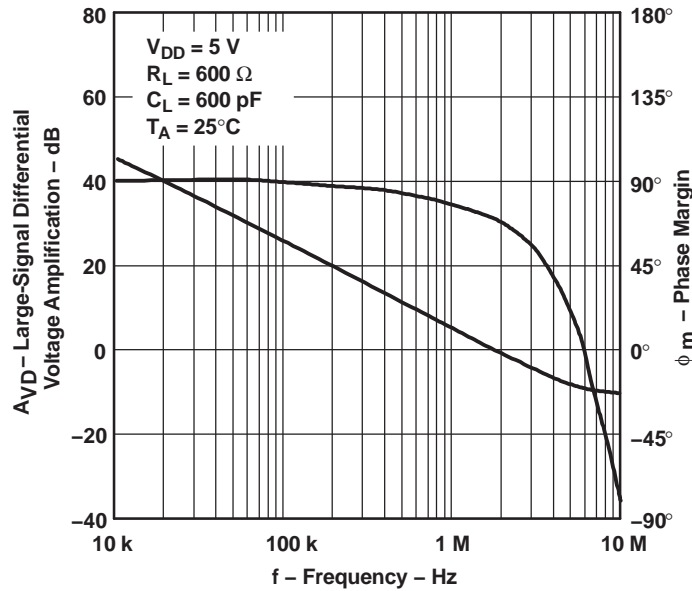


Figure 20.

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION  
vs  
FREE-AIR TEMPERATURE

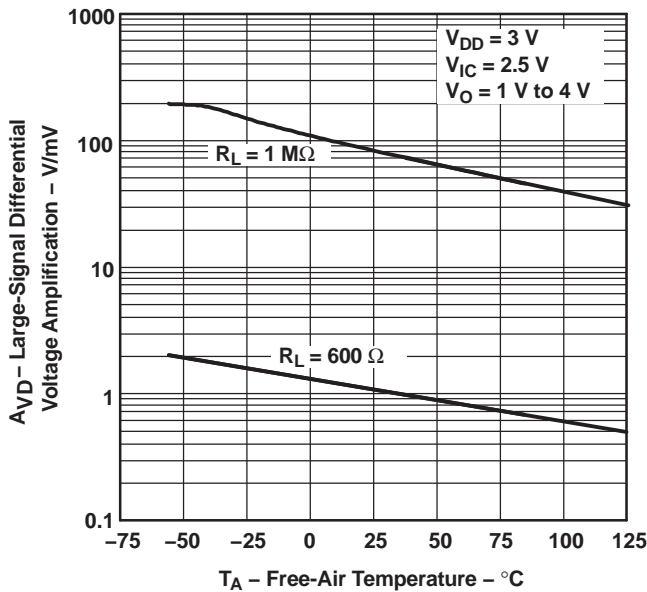


Figure 21.

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION  
vs  
FREE-AIR TEMPERATURE

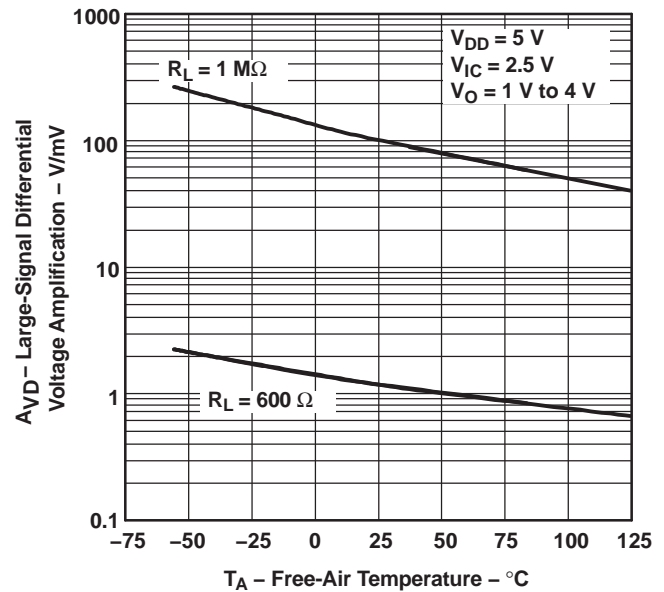


Figure 22.

OUTPUT IMPEDANCE  
VS  
FREQUENCY

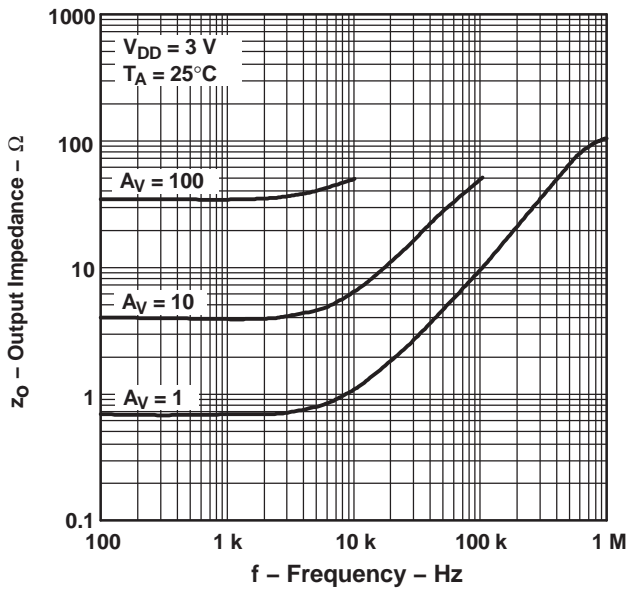


Figure 23.

OUTPUT IMPEDANCE  
VS  
FREQUENCY

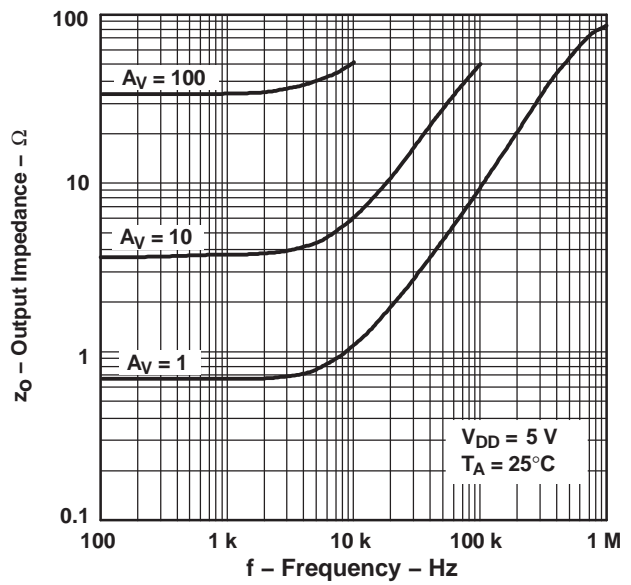


Figure 24.

COMMON-MODE REJECTION RATIO  
VS  
FREQUENCY

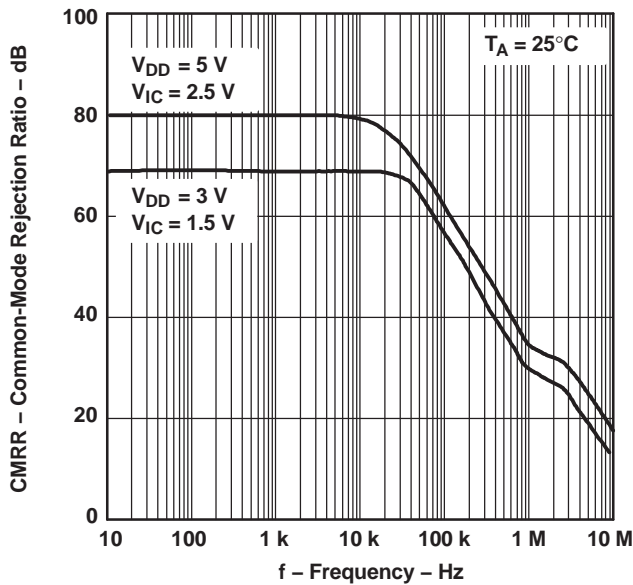


Figure 25.

COMMON-MODE REJECTION RATIO  
VS  
FREE-AIR TEMPERATURE

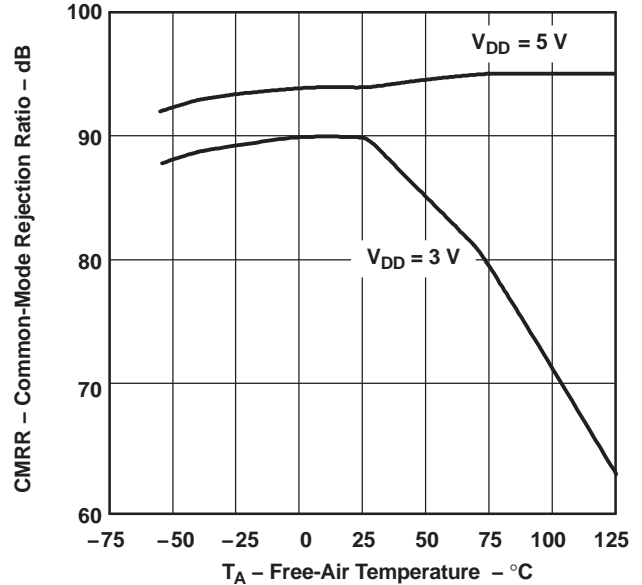


Figure 26.

SUPPLY-VOLTAGE REJECTION RATIO  
VS  
FREQUENCY

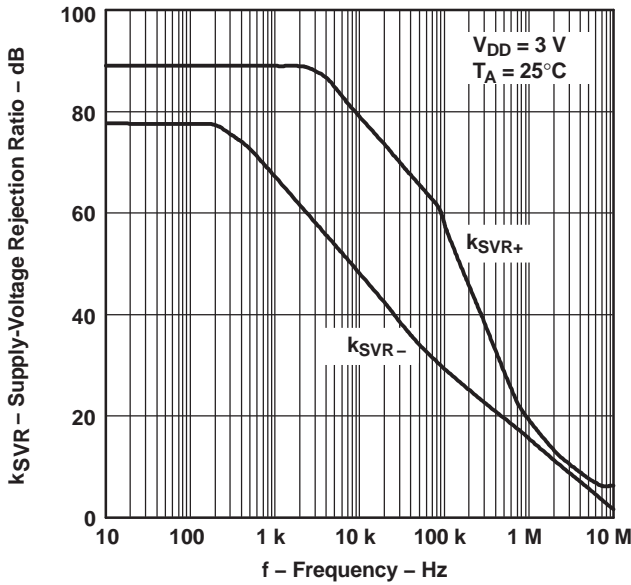


Figure 27.

SUPPLY-VOLTAGE REJECTION RATIO  
VS  
FREQUENCY

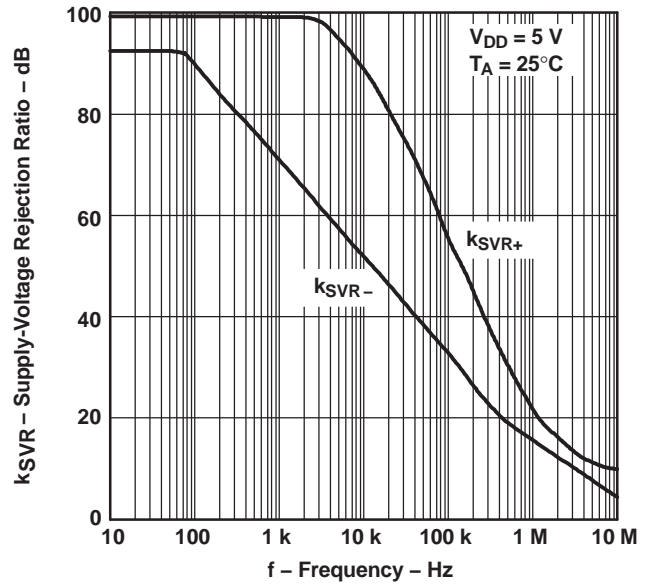


Figure 28.

SUPPLY-VOLTAGE REJECTION RATIO  
VS  
FREE-AIR TEMPERATURE

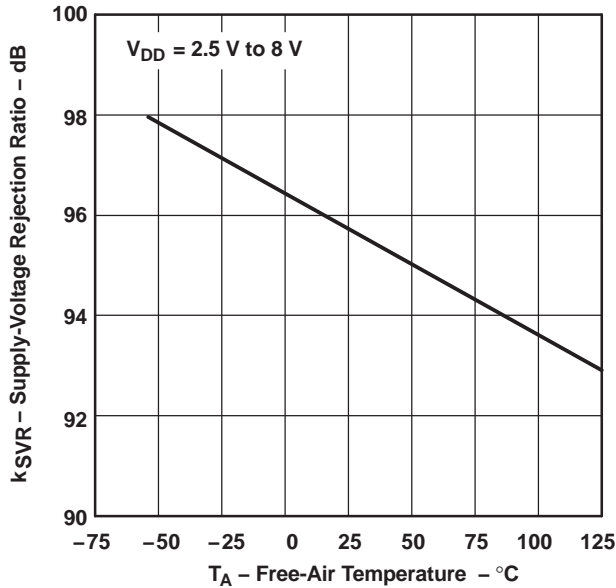


Figure 29.

SUPPLY CURRENT  
VS  
SUPPLY VOLTAGE

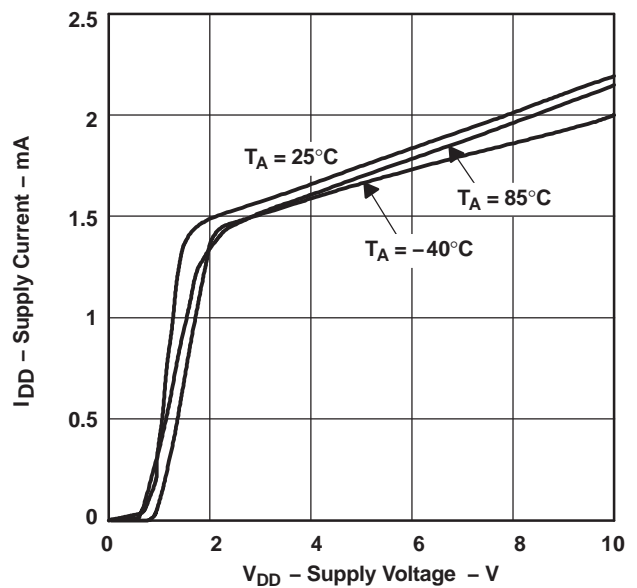
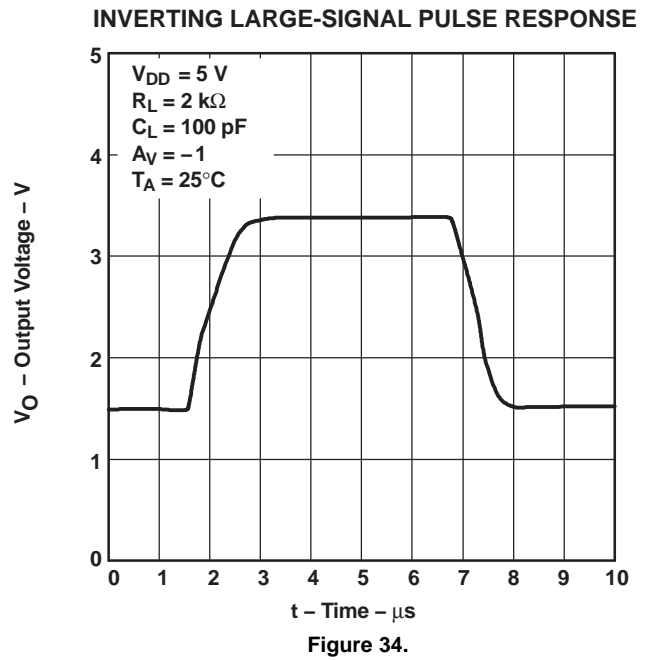
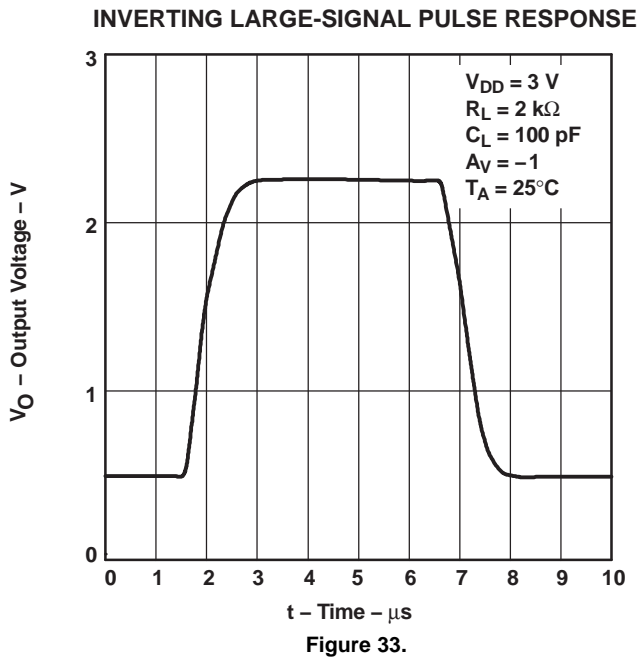
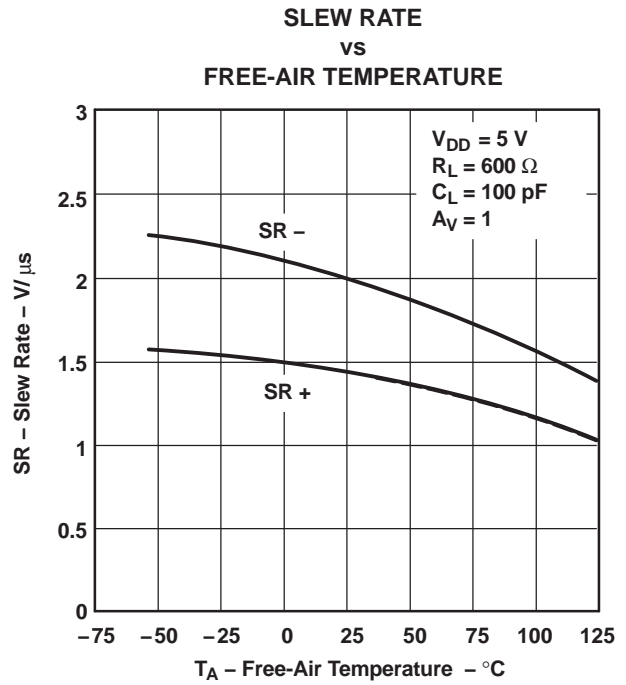
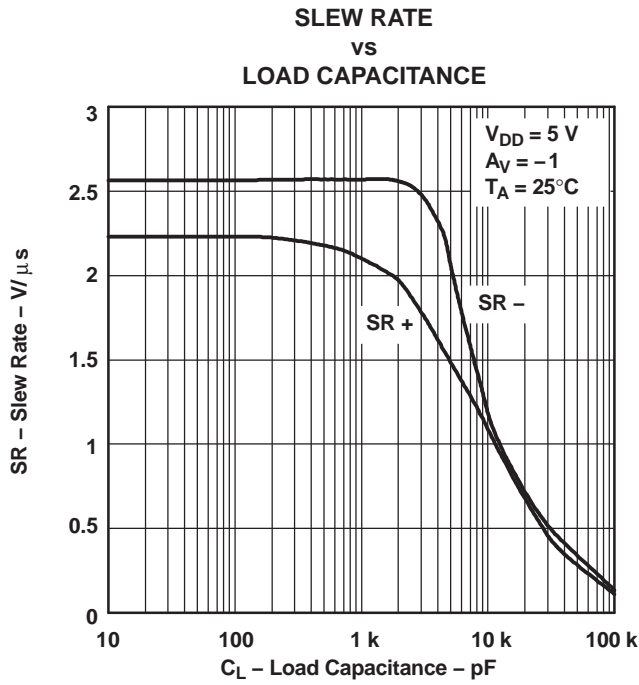


Figure 30.



VOLTAGE-FOLLOWER  
LARGE-SIGNAL PULSE RESPONSE

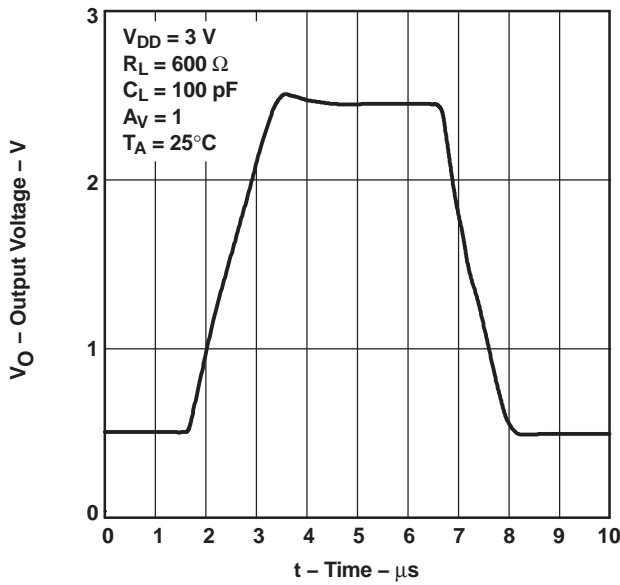


Figure 35.

VOLTAGE-FOLLOWER  
LARGE-SIGNAL PULSE RESPONSE

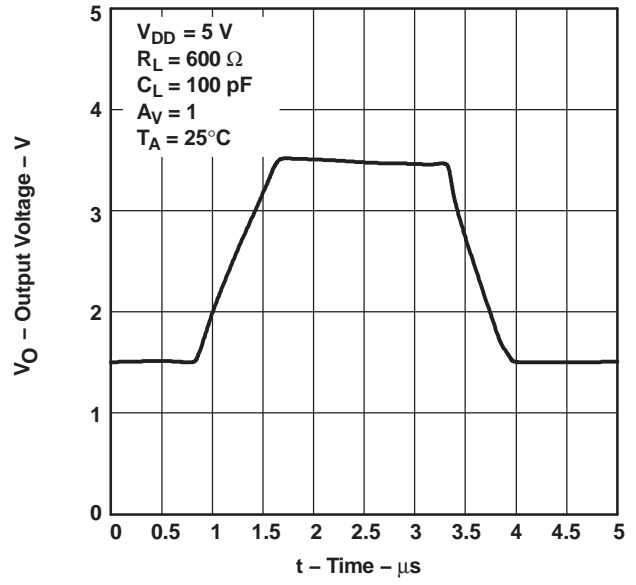


Figure 36.

INVERTING SMALL-SIGNAL PULSE RESPONSE

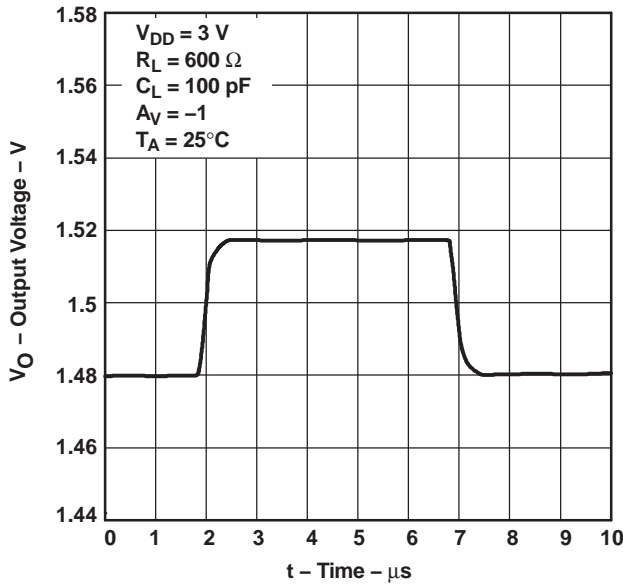


Figure 37.

INVERTING SMALL-SIGNAL PULSE RESPONSE

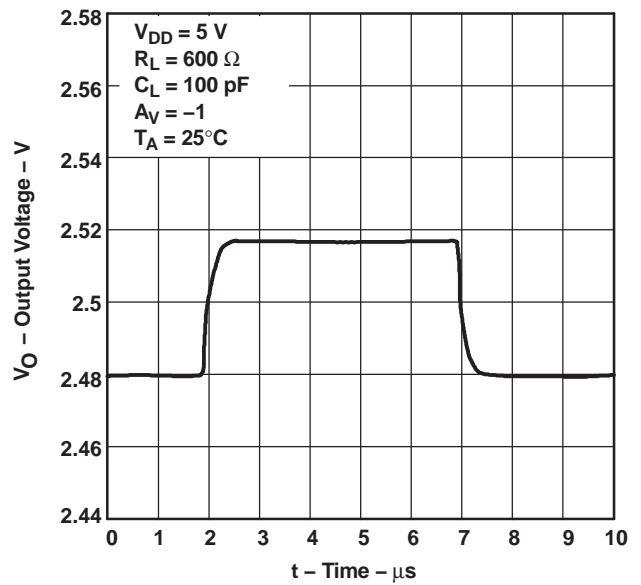


Figure 38.

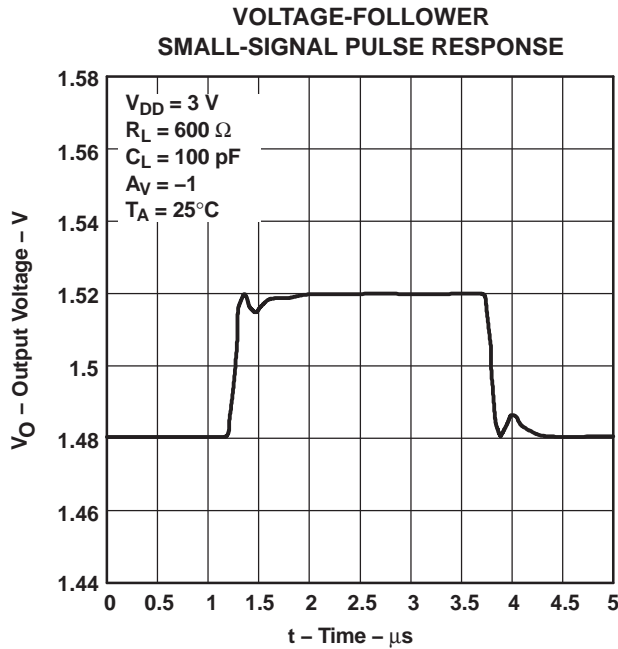


Figure 39.

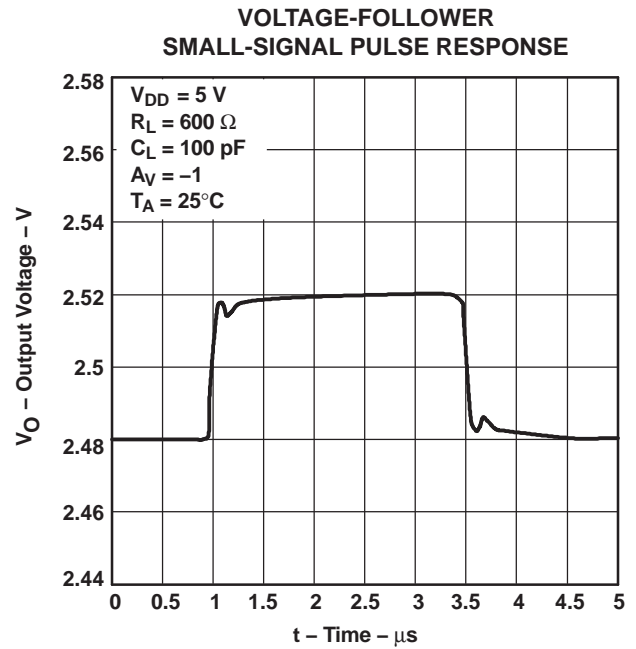


Figure 40.

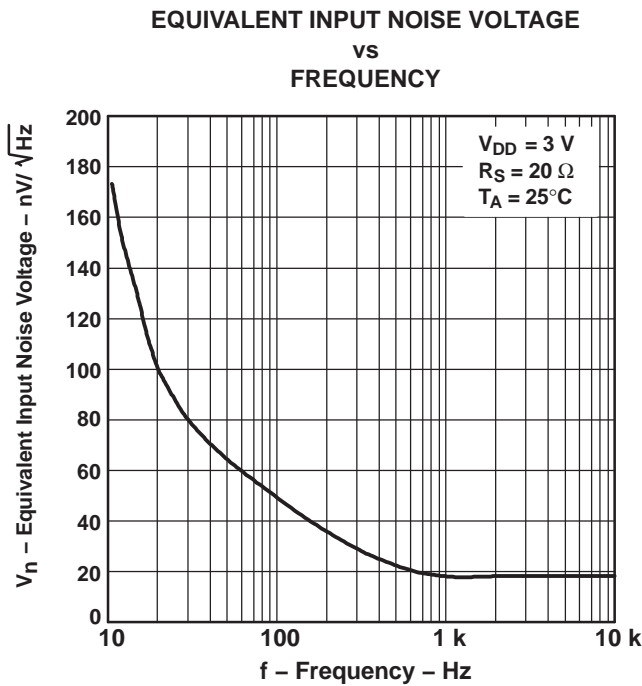


Figure 41.

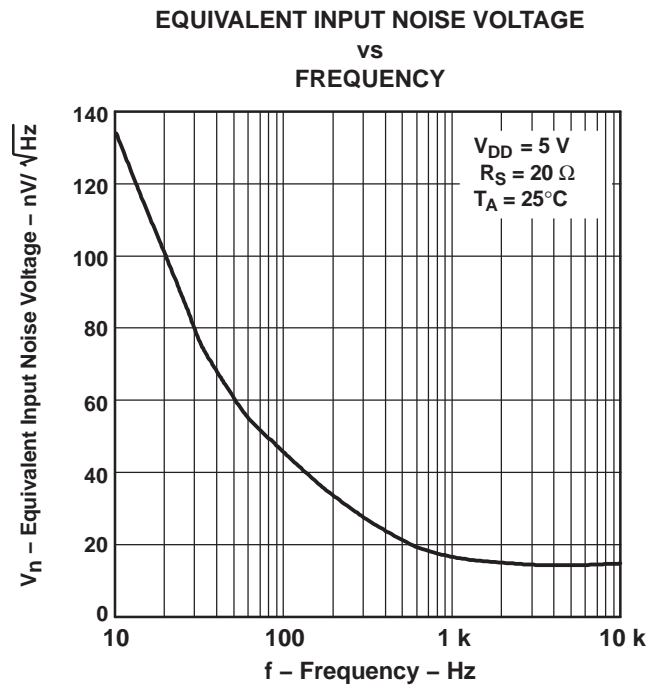


Figure 42.

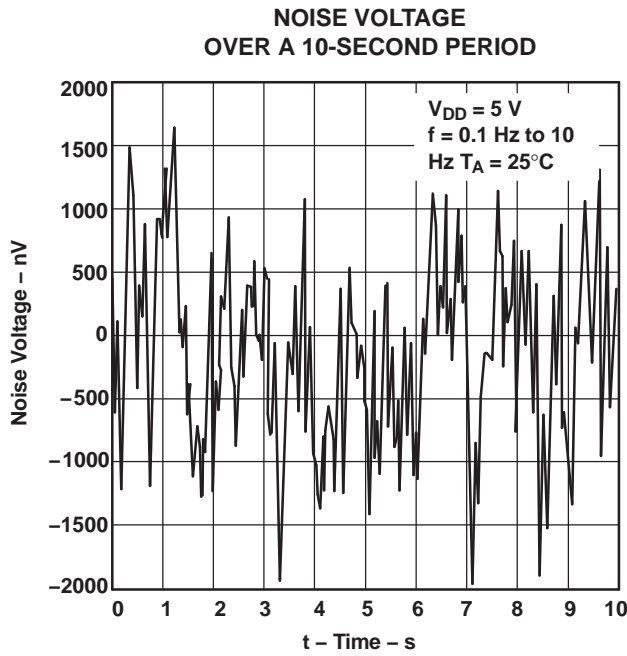


Figure 43.

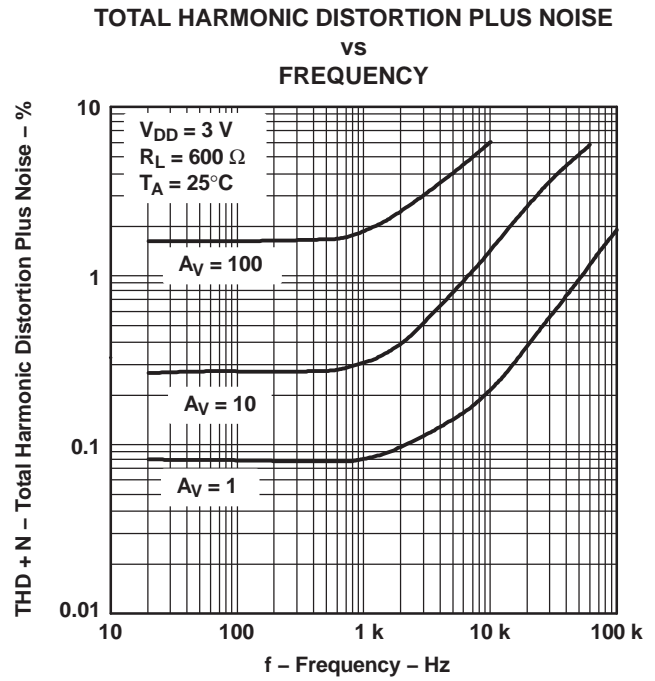


Figure 44.

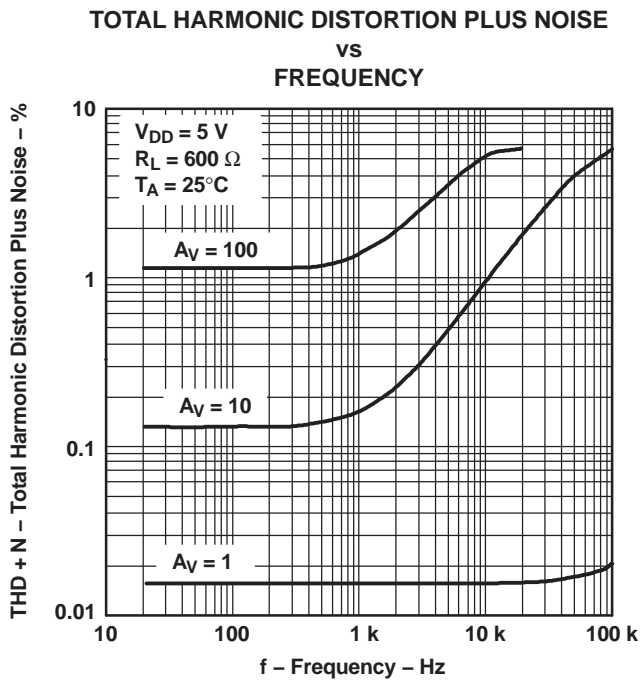


Figure 45.

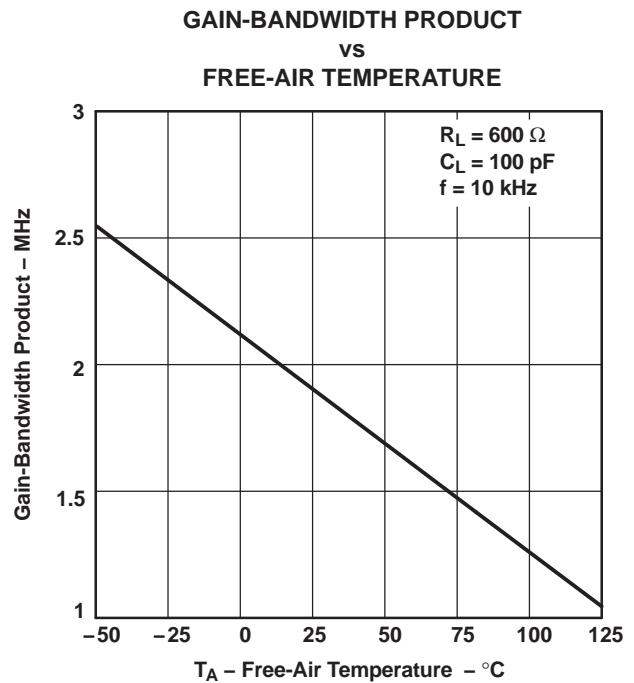


Figure 46.

GAIN-BANDWIDTH PRODUCT  
VS  
SUPPLY VOLTAGE

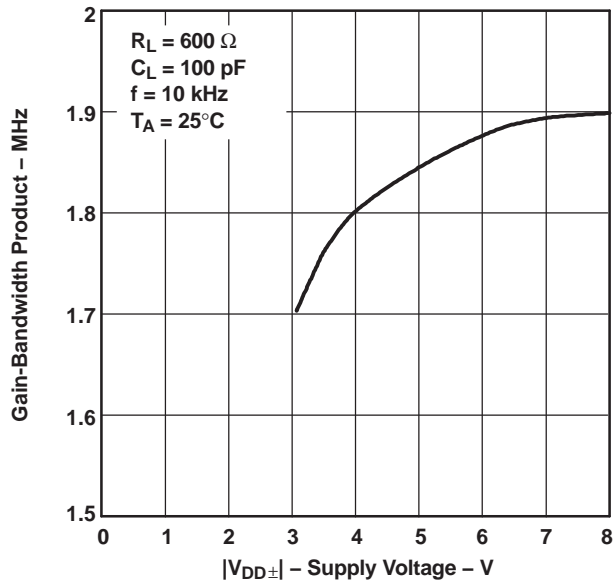


Figure 47.

PHASE MARGIN  
VS  
LOAD CAPACITANCE

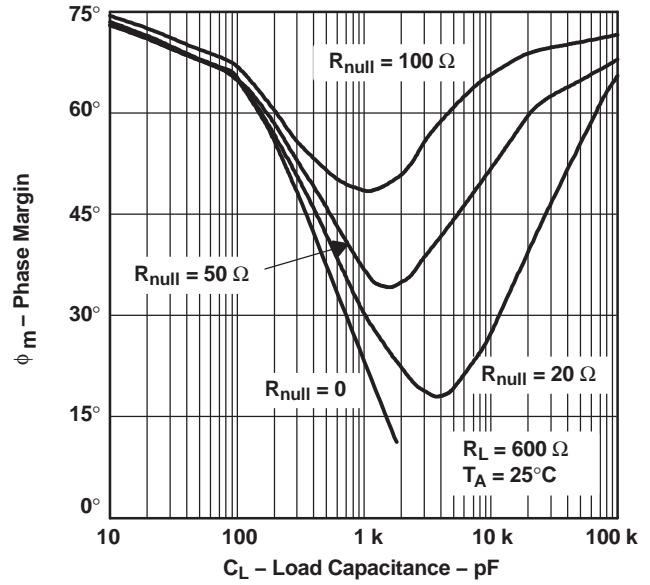


Figure 48.

GAIN MARGIN  
VS  
LOAD CAPACITANCE

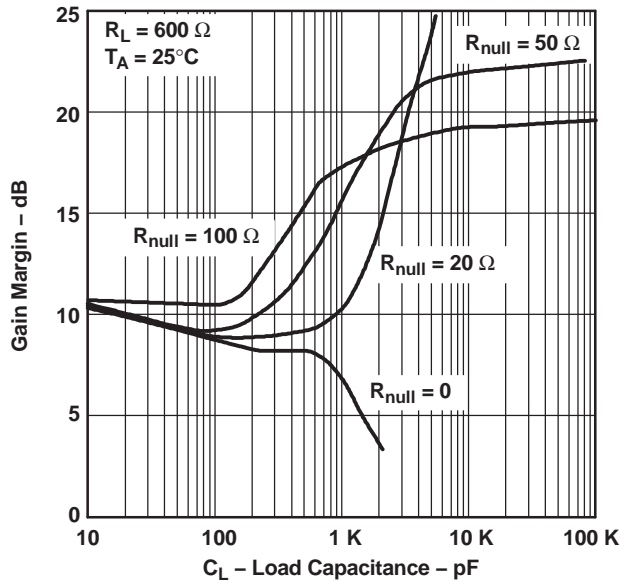


Figure 49.

UNITY-GAIN BANDWIDTH  
VS  
LOAD CAPACITANCE

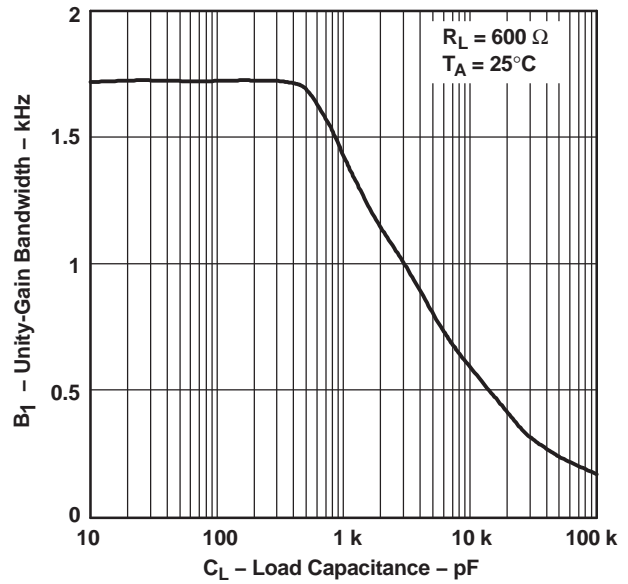


Figure 50.

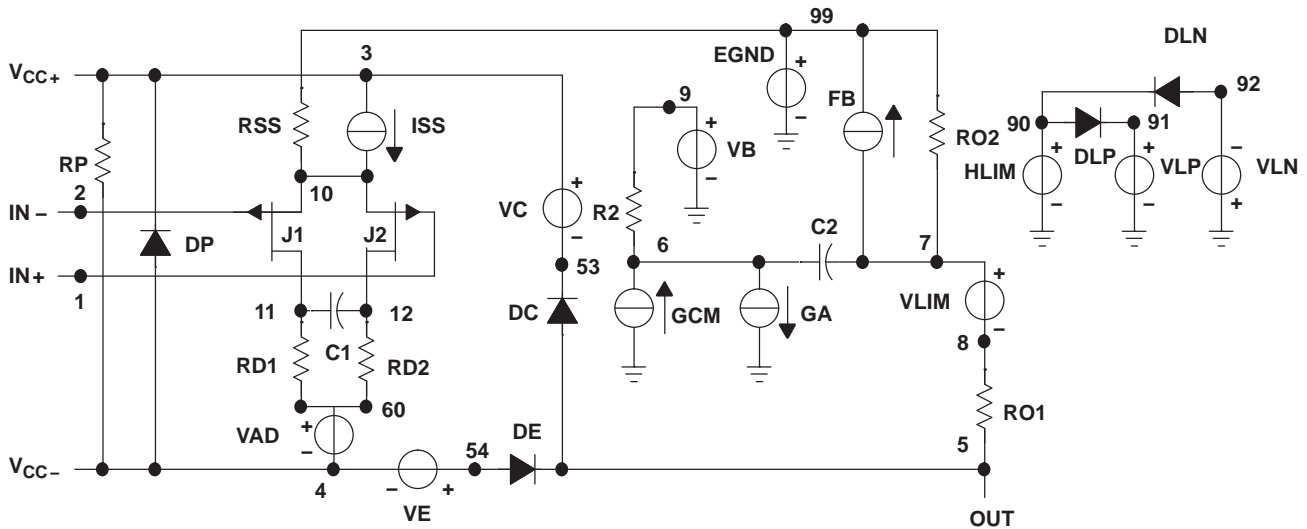
APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using PSpice™ Parts™ model generation software. The Boyle macromodel<sup>(2)</sup> and subcircuit in Figure 51 were generated using the TLV244x typical electrical and operating characteristics at T<sub>A</sub> = 25°C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

(2) G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit



```
.SUBCKT TLV2442 1 2 3 4 5
C1      11      12      14E-12
C2      6       7       60.00E-12
DC      5       53      DX
DE      54      5       DX
DLP     90      91      DX
DLN     92      90      DX
DP      4       3       DX
EGND    99     0       POLY (2) (3,0) (4,) 0 .5 .5
FB      7       99      POLY (5) VB VC VE VLP VLN 0
+ 984.9E3 -1E6 1E6 1E6 -1E6
GA      6       0       11      12 377.0E-6
GCM     0       6       10      99 134E-9
ISS     3       10      DC 216.0E-6
HLIM    90     0       VLIM 1K
J1      11     2       10 JX
J2      12     1       10 JX
R2      6       9       100.OE3
RD1     60     11      2.653E3
RD2     60     12      2.653E3
R01     8       5       50
R02     7       99      50
RP      3       4       4.310E3
RSS     10     99      925.9E3
VAD     60     4       -.5
VB      9       0       DC 0
VC      3       53      DC .78
VE      54     4       DC .78
VLIM    7       8       DC 0
VLP     91     0       DC 1.9
VLN     0      92      DC 9.4
.MODEL DX D (IS=800.0E-18)
.MODEL JX PJF (IS=1.500E-12BETA=1.316E-3
+ VTO=-.270)
.ENDS
```

Figure 51. Boyle Macromodel and Subcircuit

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)         | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| TLV2442AQDRG4Q1  | ACTIVE        | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | 2442AQ                   | <a href="#">Samples</a> |
| TLV2442AQDRQ1    | ACTIVE        | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | 2442AQ                   | <a href="#">Samples</a> |
| TLV2442AQPWRG4Q1 | ACTIVE        | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | 2442AQ                   | <a href="#">Samples</a> |
| TLV2442AQPWRQ1   | OBSOLETE      | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI              | -40 to 125   | 2442AQ                   |                         |
| TLV2442QDGKRQ1   | ACTIVE        | VSSOP        | DGK             | 8    | 2500        | Green (RoHS & no Sb/Br) | Call TI          | Level-2-260C-1 YEAR  | -40 to 125   | OBR                      | <a href="#">Samples</a> |
| TLV2442QDRG4Q1   | ACTIVE        | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | 2442Q1                   | <a href="#">Samples</a> |
| TLV2442QDRQ1     | OBSOLETE      | SOIC         | D               | 8    |             | TBD                     | Call TI          | Call TI              | -40 to 125   | 2442Q1                   |                         |
| TLV2442QPWRG4Q1  | ACTIVE        | TSSOP        | PW              | 8    | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | 2442Q1                   | <a href="#">Samples</a> |
| TLV2442QPWRQ1    | OBSOLETE      | TSSOP        | PW              | 8    |             | TBD                     | Call TI          | Call TI              | -40 to 125   | 2442Q1                   |                         |
| TLV2444AQPWRQ1   | ACTIVE        | TSSOP        | PW              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | 2444AQ                   | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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**OTHER QUALIFIED VERSIONS OF TLV2442-Q1, TLV2442A-Q1, TLV2444A-Q1 :**

- Catalog: [TLV2442](#), [TLV2442A](#), [TLV2444A](#)
- Military: [TLV2442M](#), [TLV2442AM](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV2442QDGKRQ1  | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLV2442QPWRG4Q1 | TSSOP        | PW              | 8    | 2000 | 330.0              | 12.4               | 7.0     | 3.6     | 1.6     | 8.0     | 12.0   | Q1            |
| TLV2444AQWRQ1   | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

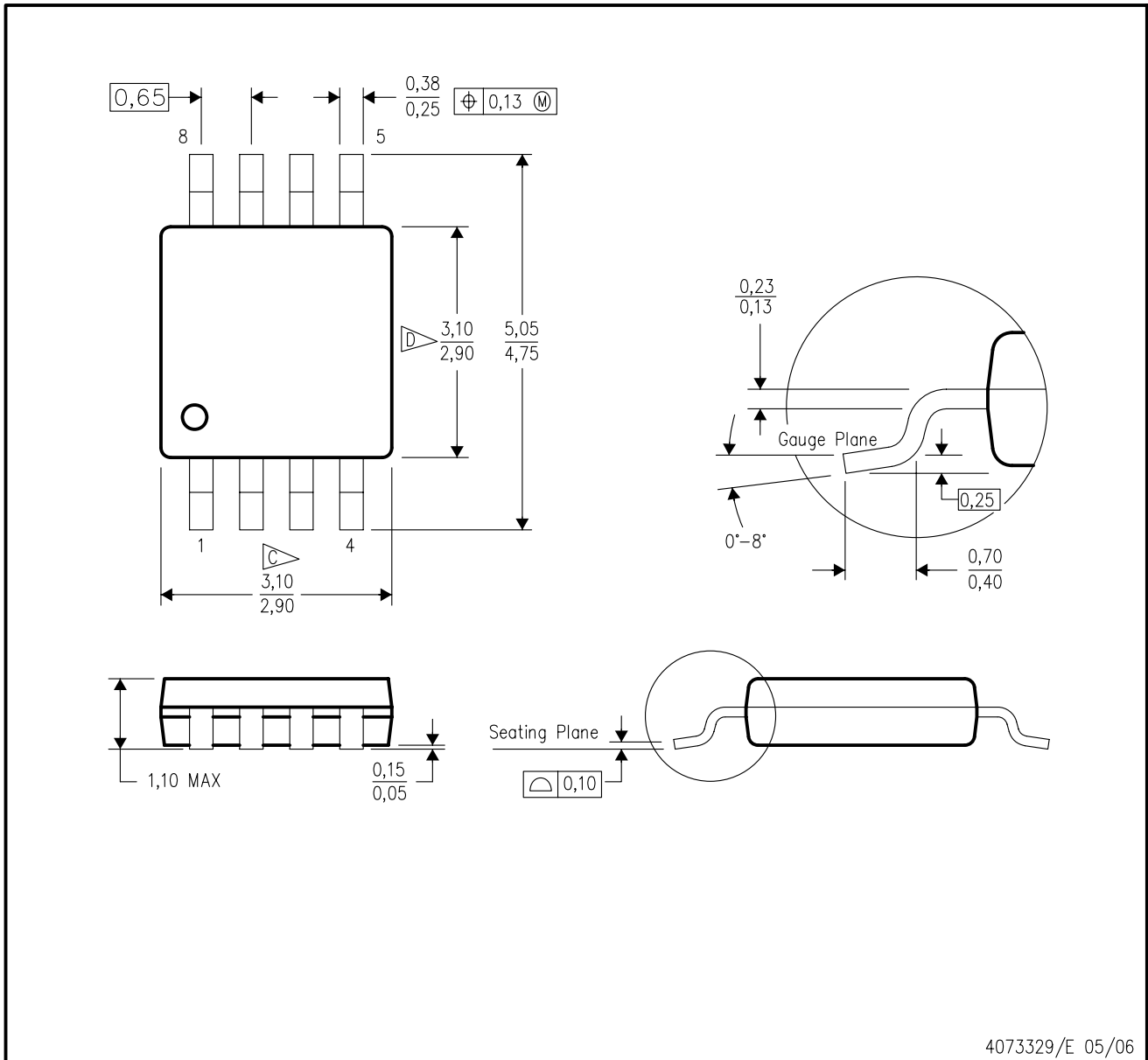
**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV2442QDGKRQ1  | VSSOP        | DGK             | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| TLV2442QPWRG4Q1 | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| TLV2444AQPWRQ1  | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

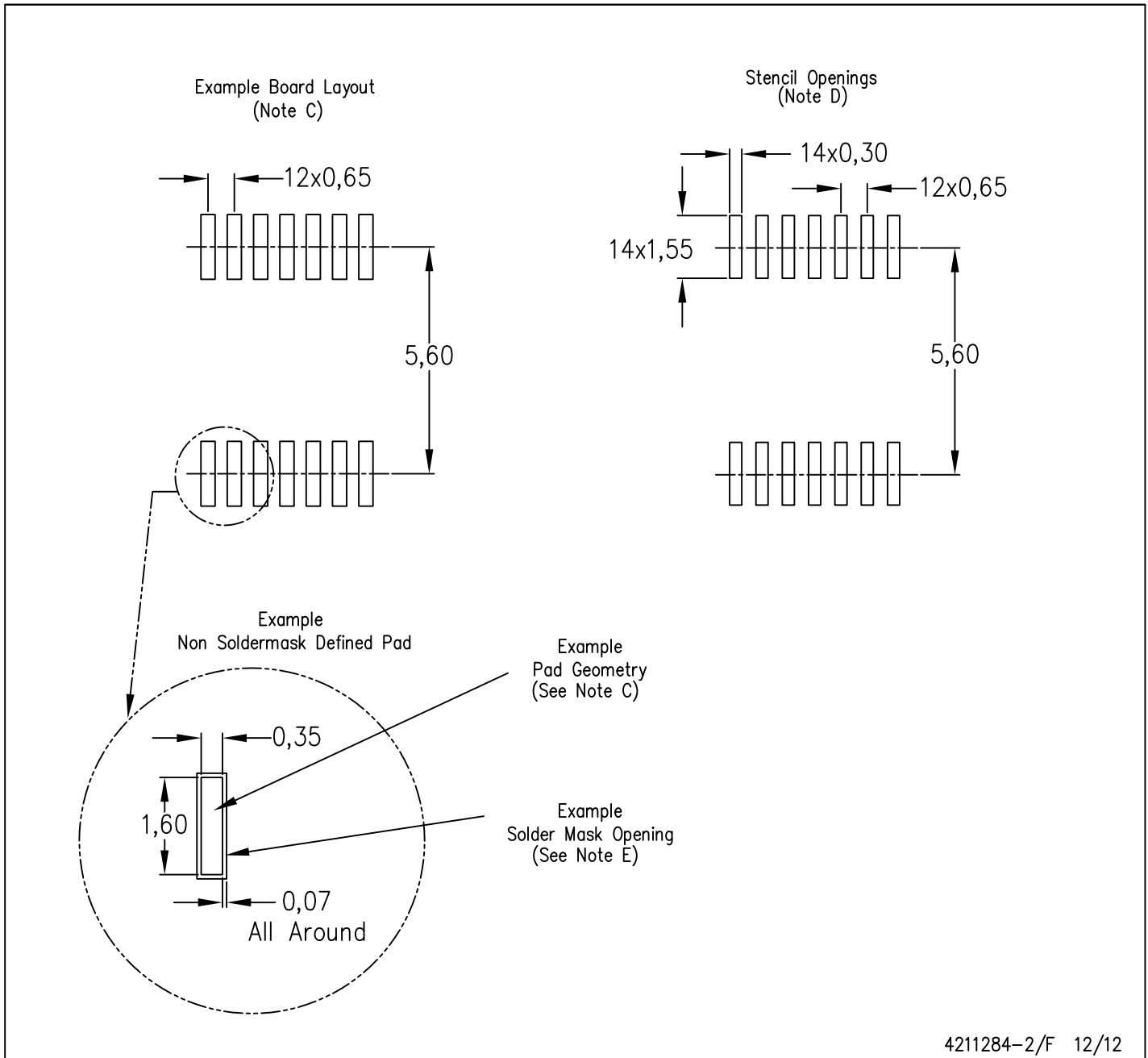


- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
  - E. Falls within JEDEC MO-187 variation AA, except interlead flash.



PW (R-PDSO-G14)

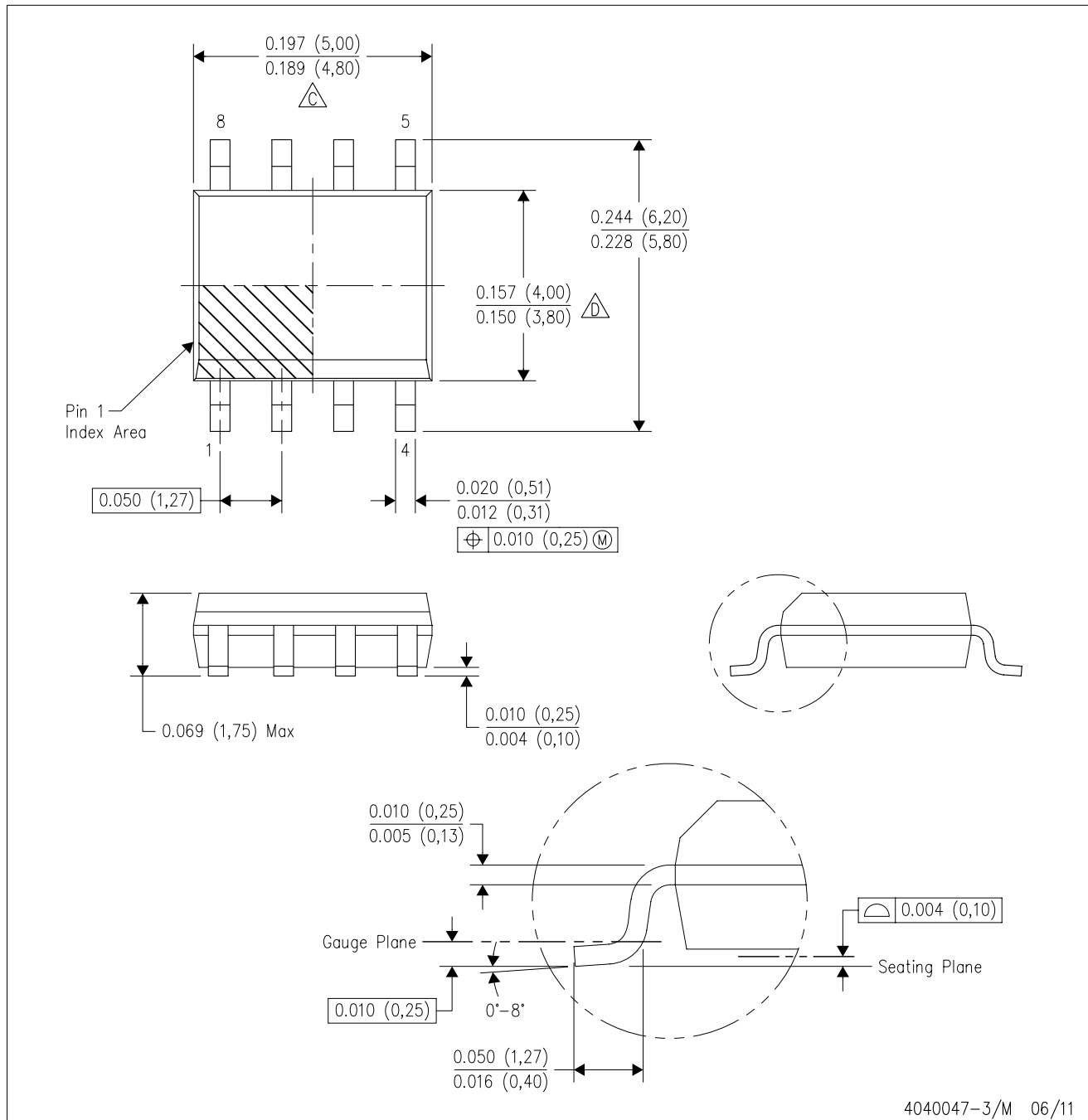
PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE

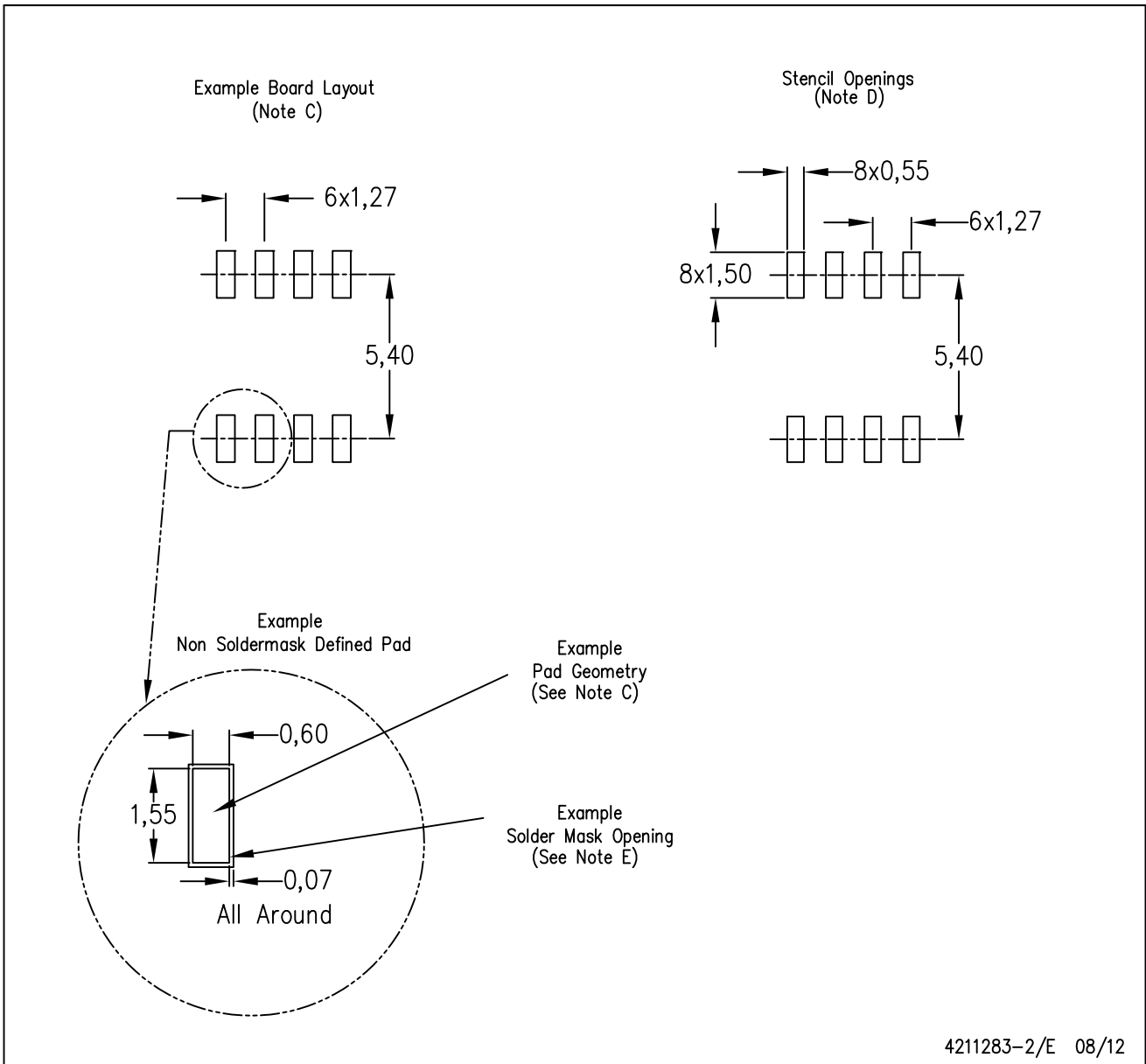


4040047-3/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE

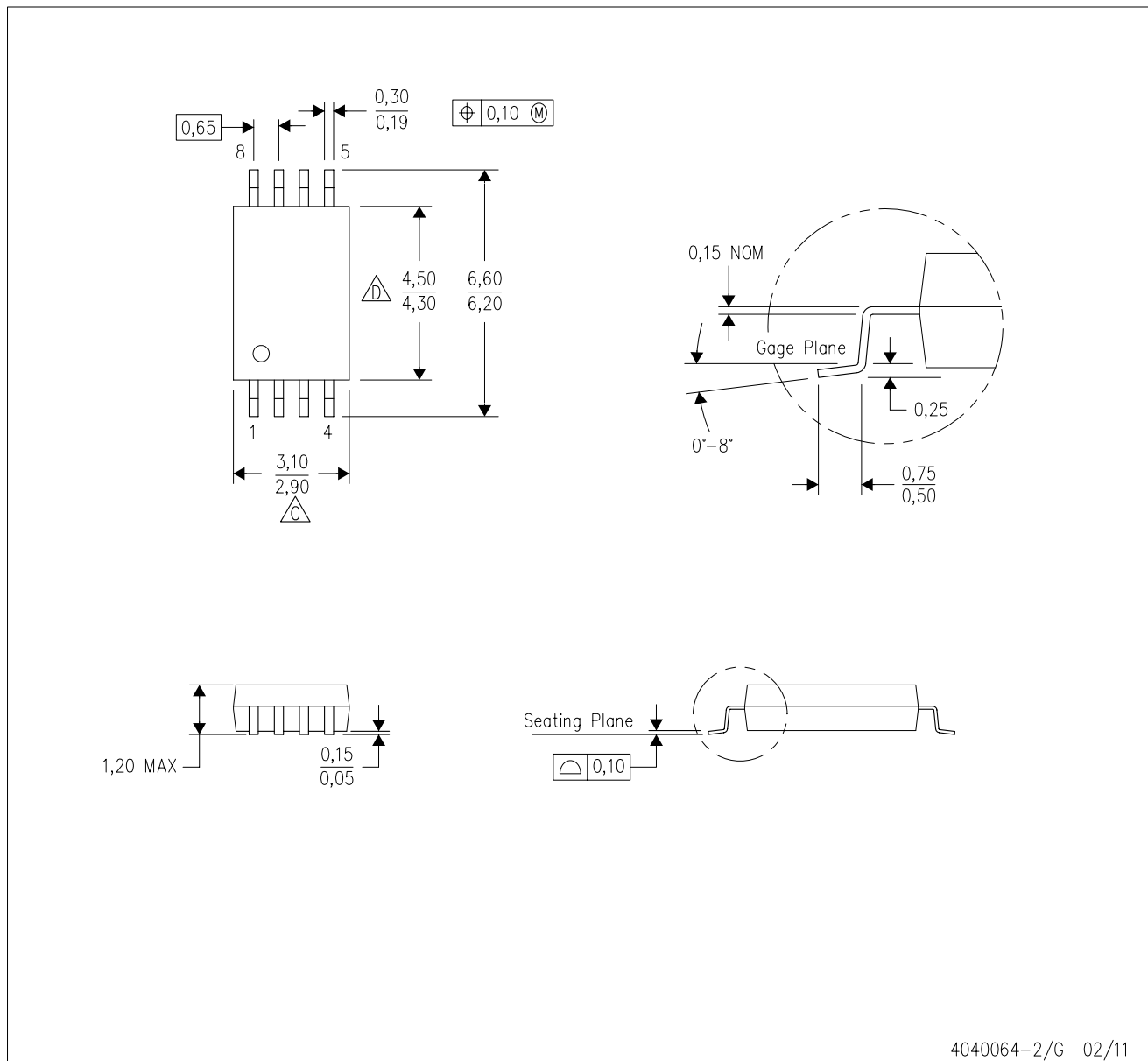


4211283-2/E 08/12

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G8)

PLASTIC SMALL OUTLINE



4040064-2/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

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|                               |  |
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